

Scanning	LIB.



SPECIFICATION FOR APPROVAL

• CUSTOMER : LG Electronics inc.

• ITEM : Power Supply Unit.

• P/NO

Model Name	Customer	Supplier
LGP4247L-12LPB-3PM	EAY62608903	PLDF-L103C

• DATE : 2013. 11. 15

• Revision : 2.3

• Remark : MP (PCB REV 2.0)

Producing District : YANTAI, CHINA (중국 연태)

(생산지)

GWANGJU, KOREA (한국 광주)

★ Safety Standard Parts [안전규격부품 List]

Power Cord, Power Plug, X/Y-Capacitor, Power Switch, Fuse, SMPS Trans, Stand-By Trans, Photo coupler, Insulation(절연) Resistor, Discharge(방전) Resistor, Fusing Resistor, FBT.CPT, CPT Socket, DY, D-Coil, Line Filter, PCB Material, Front / Back-cover Material Relay(1-2차간), Varistor, Adapter

★ EMC Standard Parts [전자규격 부품 List]

Power Plug, Line Filter, X-Capacitor, Y-Capacitor, SMPS Trans, Tuner, Saw-Filter, Shield Case, Oscillator, Pattern Change

★ Green [유해물질 확인사항]

This item must meet the standards of LG Electronics for six major substances as designated by RoHS for control.

(Cd: 10ppm under, Pb/Hg/Cr+6/PBB/PBDE: 100 ppm under)

 LG Innotek	LG Innotek Co., Ltd
	LG Twin Tower 33/34F, Yeouido-dong,
	Yeongdeungpo-gu, Seoul, Korea
	Tel. : +82-2-3777-1114
	Fax. : +82-2-3777-0082

Documentation For Approval

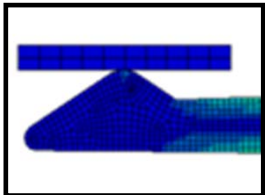
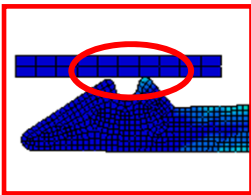
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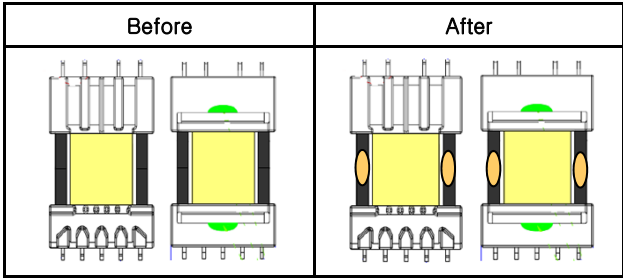
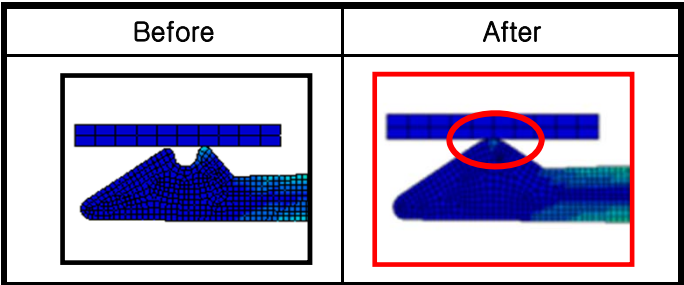
Written	Checked		Approved
J.S Lee	K.T Choi		S.H JANG

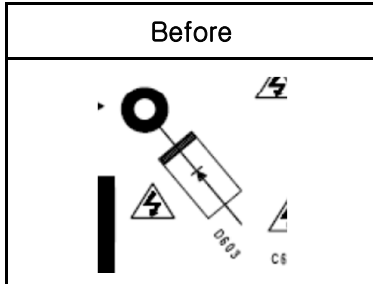
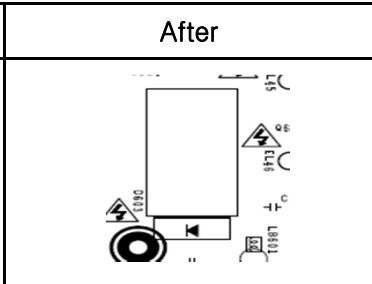
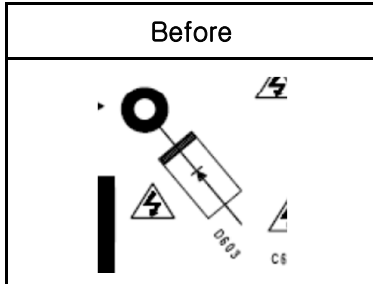
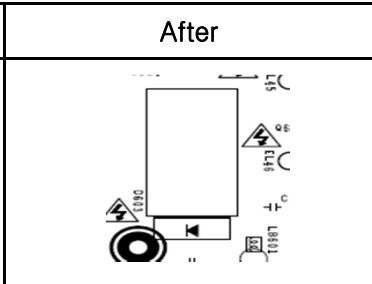
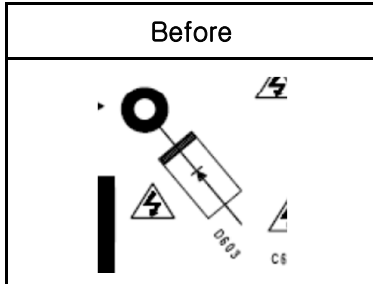
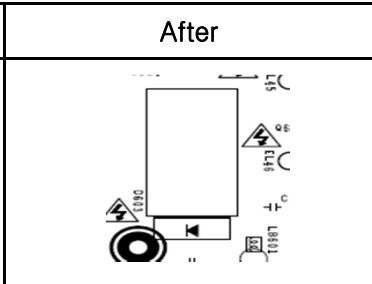
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Revision History

Rev No.	Contents	Date of Approval	Checked	Remark
1.0	Apply to PV (PCB REV 1.0) PCB P/No. EAX64744204(1.3) Micom Ver : 1.00a (Checksum : 0x2214)	12.03.05	K.T.Choi	
1.1	Apply to MP (PCB REV 1.0) PCB P/No. EAX64744204(1.3) 1. Reduce the size of Air vinyl - Before : 760L * 200W - After : 585L * 220W	12.04.23	K.T.Choi	
1.2	Apply to MP (PCB REV 1.0) PCB P/No. EAX64744204(1.3) 1. Change FFC Connector contact point for improving contact N.G. ISSUE. Before  After 	12.05.11	K.T.Choi	
1.3	Apply to MP (PCB REV 1.0) PCB P/No. EAX64744204(1.3) 1. Add ST product site. (STF13NM60-Q601,Q602) - Longgang / China : Assy Plant Code – G4	12.06.11	K.T.Choi	
1.4	Apply to MP (PCB REV 1.0) PCB P/No. EAX64744204(1.3) 1. Change 1uF, 2.2uF MLCC VENDOR. - ONLY USE TDK, MURATA. - APPLY TO 2012. 07. 01.	12.06.20	K.T.Choi	

Rev No.	Contents	Date of Approval	Checked	Remark
1.5	Apply to MP (PCB REV 1.0) PCB P/No. EAX64744204(1.3) 1. Apply STBY Trans (12S-LS01) which has additional bonding points to improve noise. - Maker : FEELUX - Location : T501 - Bonding points : Top side of core junction Bottom side of core junction 	12.06.29	K.T.Choi	
1.6	Apply to MP (PCB REV 1.0) PCB P/No. EAX64744204(1.3) 1. Change FFC Connector contact point for improving contact N.G. ISSUE. 	12.07.10	K.T.Choi	
1.7	Apply to MP (PCB REV 1.0) PCB P/No. EAX64744204(1.3) 1. Box Change - Add : Box Silk (Bar Code and Tape Line)	12.08.24	K.T.Choi	

Rev No.	Contents	Date of Approval	Checked	Remark				
2.0	Apply to MP (PCB REV 2.0) PCB P/No. EAX64744204(1.5) 1. Change the type of PFC Output Diode - Location : D603 - Axial type → TO-220 type <table border="1"><thead><tr><th>Before</th><th>After</th></tr></thead><tbody><tr><td></td><td></td></tr></tbody></table>	Before	After			12.10.18	K.T.Choi	
Before	After							
								
2.1	Apply to MP (PCB REV 2.0) PCB P/No. EAX64744204(1.5) 1. Change BOX - To keep C251 from taking off the PCB - Size : 509X280 → 509X204 - Partition : 16EA → 13EA <table border="1"><tbody><tr><td>Before</td><td></td></tr><tr><td>After</td><td></td></tr></tbody></table>	Before		After		12.11.01	K.T.Choi	
Before								
After								

Rev No.	Contents	Date of Approval	Checked	Remark
2.2	Apply to MP (PCB REV 2.0) PCB P/No. EAX64744204(1.5) 1.Change production site of LGIT Trans - LGIT Yantai → CLOVER Mundeung OEM	13.01.10	K.T.Choi	
2.3	Apply to MP (PCB REV 2.0) PCB P/No. EAX64744204(1.5) 1. L6599AD change assembly site and material As is ; Before Change I. Old Assembly site : Amkor in Philippines → "B" marking II. Labels : Assembled in Philippines III. Old Wire : Au To be ; After Change I. New Assembly site Shenzhen in China → "K" marking II. Labels : Assembled in China III. New Wire : Copper(Cu) 2. 4M Change Process 1)Responsibility of 4M Change ; LGE 2)Running Change ; Yes 3)Goods of Stock ; no rework	13.11.15	K.T.Choi	

Software Revision History

No.	Firmware Revision Contents	Date of Approval	Checked	Remark
1	- Firmware Version 1.00a Checksum 0x2214	11.12.14	J.Y Kim	

CTQ Management

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Specification

1. INTRODUCTION

1.1 Scope

This approval is the description related to every electrical and structural specifications and reliability For Power Supply Unit used on 42 inch, 47 inch LGE LED TV.

1.2 Customers product related items

Product : Power Supply Unit

Part code : EAY62608903

1.3 Product name

Product name : PLDF-L103C

Revision code : 2.3

2. SPECIFICATION

2.1 Input Requirements

Nominal Input Voltage	AC 100V to AC 240V
Input Voltage Variation	AC 90V to AC 264V
Input Current	Under 1.5Arms . (at 100Vac & Nominal Load) Under 0.8Arms . (at 240Vac & Nominal Load)
Nominal Frequency	50 / 60 Hz
Frequency Variation Range	47 Hz to 63 Hz
Phase	Single
Leakage Current	0.7mA_peak. (100Vac ~ 240Vac)
Surge Immunity	$\pm 4\text{kV}$ / 1000ns / 0° to 360°
Hold-up Time	More than 20ms at 100Vac and maximum output load
Lightning Surge	2kA Normal, Common Mode
Inrush Current	80A zero-peak max at cold start and any specified line, load, temperature conditions.

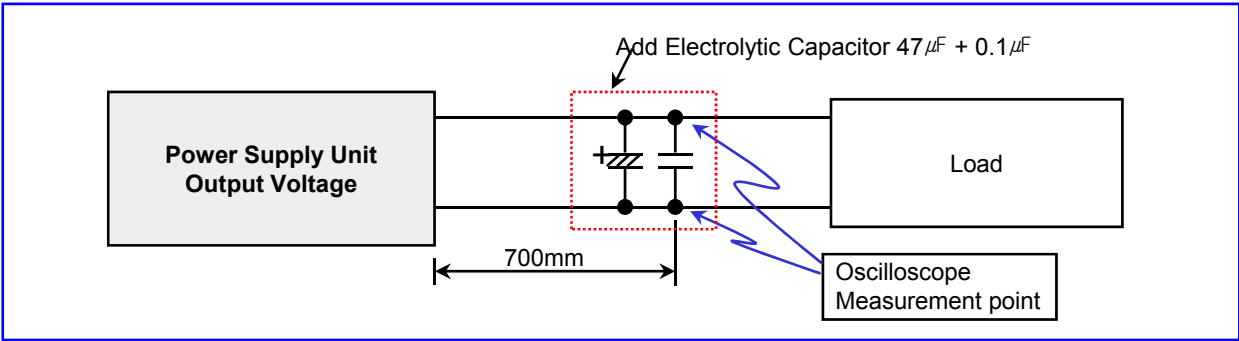
2.1.1 Power Factor

over than 0.9 at 90 – 264Vac & max load condition

2.2 Power Output Characteristics

Output		Voltage Variable range [V]	Rated Current (Min, Max) [Amean]	Voltage Regulation [V]	Ripple Voltage [mVp_p]
	3.5V (STBY)	3.3V ~ 3.7V	0.3W Under(15mA)	-	-
			1.5A(0~1.5A) (ON condition)	± 5%	250 mVp_p
	12V	11.4V ~ 12.6V	1.8A (0.1~1.8A)	± 5%	350 mVp_p
	24	21.6V ~ 26.4V	0.8A (0.1~0.8A)	± 10%	500 mVp_p
	LED B+	49.3V ~ 75.2V	0.130A(0.1261~0.1339A) × 6Ch	-	-

- * On Condition : In a moment of Power_ON Signal activated, the current of 3.5V output should be limited within 40mA(Max) at LCD TV condition for stability.
Do not turn “Power_ON” Signal on at the load condition of 3.5V output, more than 40mA.
- * Total regulation for each output circuit includes the results of input voltage variation, load variation, warm-up drift and temperature change.
- * The following instruments shall be used for measuring ripple noise.
 1. Probe having impedance ratio of 1:1.
 2. Oscilloscope having frequency characteristic of 100MHz or more.Test Point : power output each pin



※ Ripple and noise are measured at the end of output cable which are added a 0.1uF ceramic capacitor and 47uF electrolytic capacitor. (connected parallel)

2.2.1 Stand By Power Consumption

Output Voltage	3.5V (STBY)	12V	24V
Load [A]	0.015	Don't Care (Power-Off)	
Wattage [W]	Less than 0.3W Under (230Vac / 50Hz)		

2.3 Environment Requirement

Operating Temperature Range	-10℃ to 40℃ (60℃:No Hardware Failure, TV SET Condition)
Operating Humidity Range	30 to 85 %
Storage Temperature Range	-25 to 85 deg.
Storage humidity Range	5 to 90 %
MTBF (Mean Time Between Failure)	50,000 hour
Cooling Condition	Natural Air
Shock	98 m/s ² Shock test consists of pivoting the power supply, from one edge of it's bottom side, on a flat surface (such as wood having thickness of 10mm or more) and allowing the opposite edge to fall from a height of 50mm to this surface. The test is performed three times on each edge of the bottom side of the power supply

2.4 Dielectric Strength Voltage and Insulation Resistance



Dielectric Strength Voltage	AC 1.5KV or DC 2121V 1Min 10mA (Test SPEC) AC 1.8KV 1 SEC 10 mA.(PSU Mass Production) Between Primary and All Secondary Circuits.
Insulation Resistance	Insulation resistance shall be more than 8M ohm (at DC 500V) Between Primary Live, Neutral line and Secondary.

* Above tests are performed at room temperature in non-condensing atmospheric conditions

* Frame grounds are connected to secondary circuits.

2.5 Burn-in

More than 2 hours at 40℃ (±5℃), Normal input voltage.

AC on/off must be test 1 time after burn-in.

80% Load (except LED String current : 130mA) of specification.

2.6 Interface

Appellation	Explanation	Signal Direction	Action
POWER ON	Vcc Circuit ON/OFF	Input	High : Vcc ON Low : Vcc OFF

2.7 Product Safety



Safety Standards to be applied	Design to meet the requirements as follows UL60950, IEC60950, IEC60065 and 60950
EMI/RFI Standards to be applied	Design to meet the requirements as follows FCC and EN55020, EN55013 Class B with 4dB minimum margin.

2.8 Construction

Weight	Less than 900g
Unit Size (typ.)	176(W) X 245(D) X 18.9(H)

2.9 Function of protection

Protection	Output Circuit	Trip point		Notes
		Min	Max	
Over Current	STBY 3.5V	2.5A	8.0A	Auto Re-start
	12V	3A	20.0A	Latch
	24V	1.5A	12.0A	Latch
Short Circuit	STBY 3.5V	-	-	Auto Re-start
	12V	-	-	Latch
	24V	-	-	Latch

- * This Power Supply has above-mentioned protections.
- * Short circuit protection between different output terminals is not considered.
- * Trip point for over voltage indicates the operating point when the output voltage slowly increases.
- * The conditions of Over Current measurement
Multi output(3.5V,12V,24V) is nominal load state except an over current measurement.

2.10 Sound Noise Characteristics.

PSU Noise Specification

22.5 dB(a) / 20.μ Pa 2.0E-5 Pa

(1/1 octave, A-weighting, to 1kHz ~ 16kHz Total overall

Measure Location : Anechoic Room

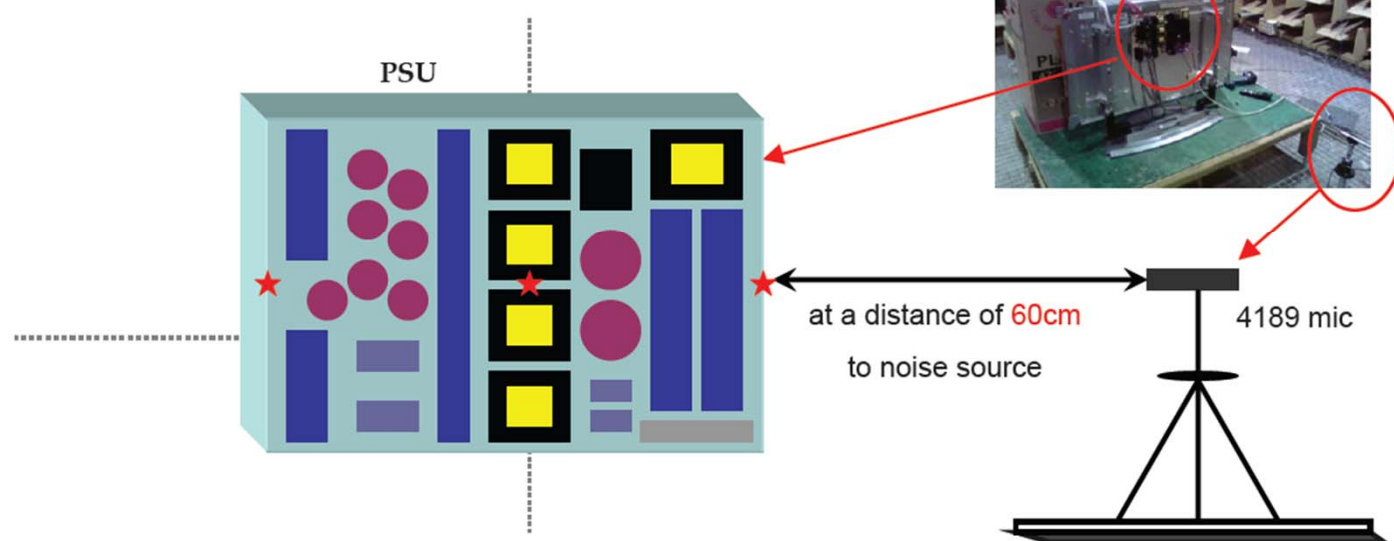
Measure Condition : At a distance of 60cm mic

Full white pattern, at AC 110V/220V

The max specification

(measure 3 points, at PSU center and left & right on the side)

PSU NOISE MEASURE POINT



2.11 Connector Specification

2.11.1 Connectors Usage

SK100 (90011WR-H03D) (Black angle type)

No	Name
1	LIVE
2	GND
3	NEUTRAL

P701 (SMAW200A-H08A2)

No	Name
1	VSYNC_IN
2	I2C_SDA
3	I2C_SCL
4	SIN
5	GND
6	SCLK
7	N.C
8	REVERSE

P702 (20010WR-06A03)

No	Name
1	MICOM_VDD
2	RXD
3	TXD
4	TOOL 0
5	RESET
6	GND

P201 (SMAW200-H24S2)

P201			
1	Power on	2	24V
3	24V	4	24V
5	GND	6	GND
7	GND	8	GND
9	3.5V	10	3.5V
11	3.5V	12	3.5V
13	GND	14	GND
15	GND	16	V-SYNC
17	12V	18	DRV_ON
19	12V	20	N.C
21	12V	22	PWM Dim#1
23	PWM Dim#2	24	Error_out

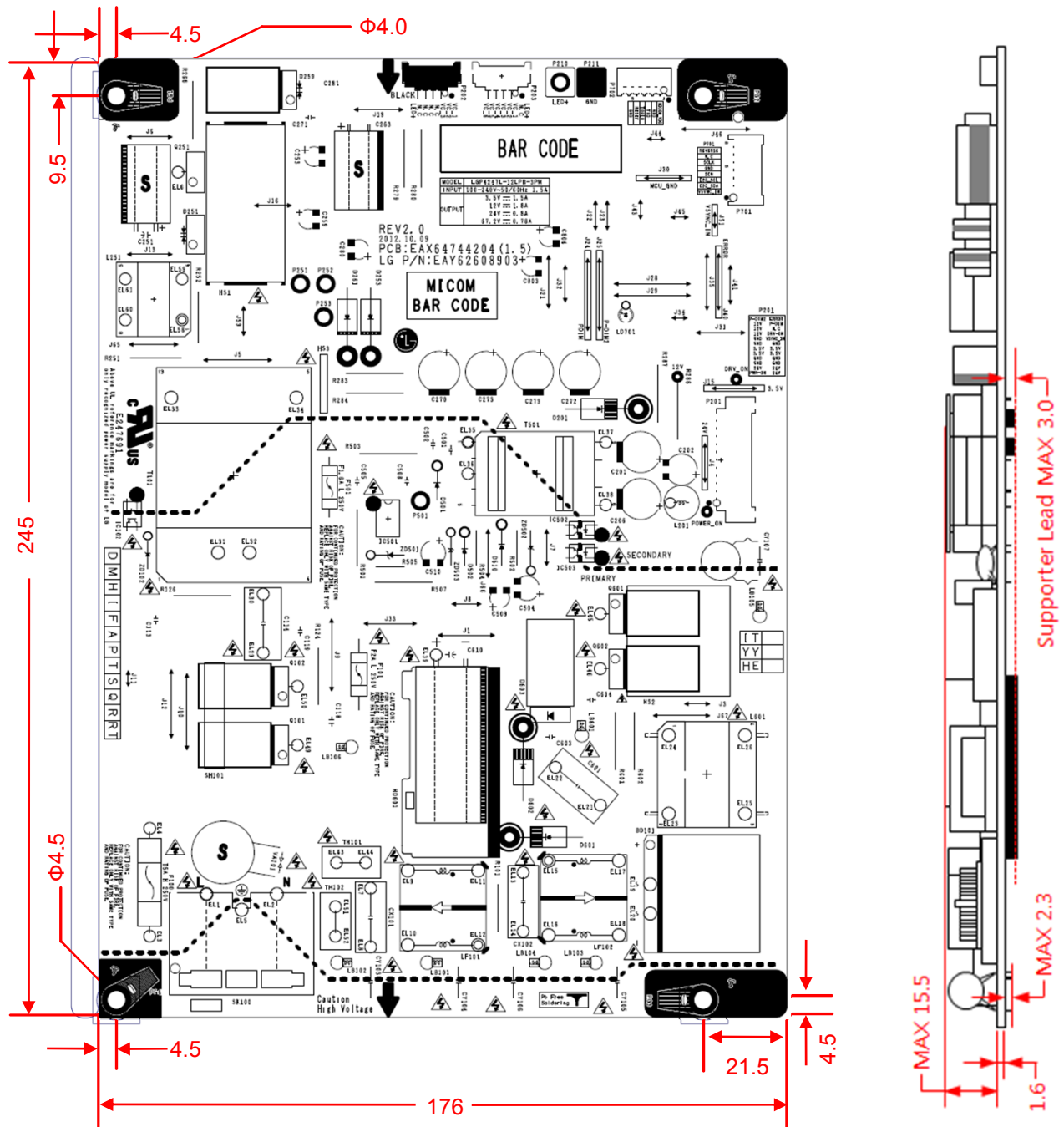
P202 (IS100-L08T-C46) (BLACK)

No	Name
1	VC_6
2	VC_5
3	VC_4
4	VC_3
5	VC_2
6	VC_1
7	N.C
8	LED +

P203 (IS100-L08T-C46-A) (WHITE)

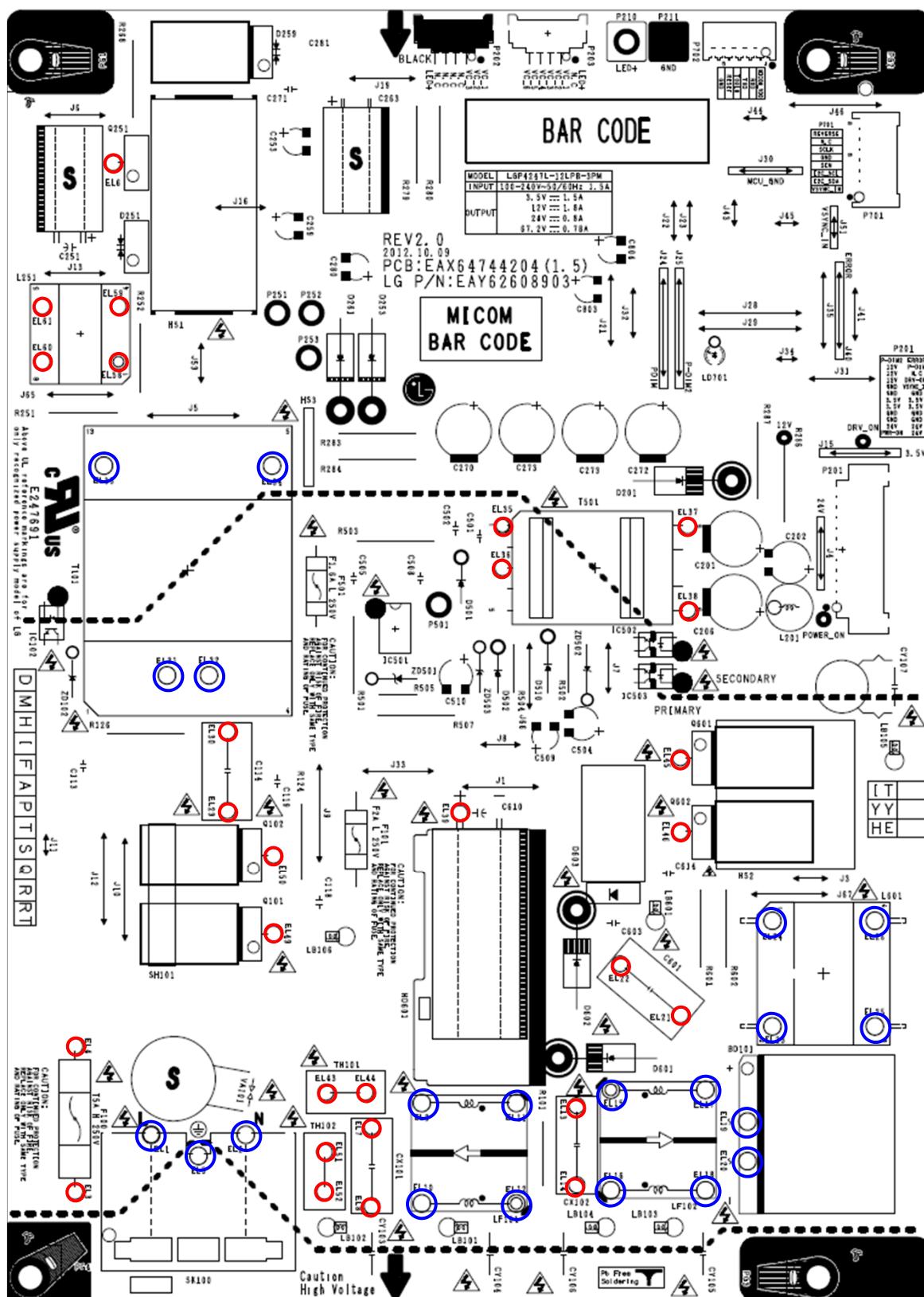
No	Name
1	LED +
2	N.C
3	VC_12
4	VC_11
5	VC_10
6	VC_9
7	VC_8
8	VC_7

2.12 PCB Dimension. (CTI - 600)



- 1) Power board PCB : 176mm X 245mm X 1.6(T)mm
- 2) Component height ; Max 15.5mm
- 3) Lead Cutting : Max 2.3mm (except HD Max 3.5mm)
- 4) PCB Material : FR-1,KB,DS,L,R-8700 CTI-600

Apply to the small Eyelet point 1.6Φ : EL3,EL4,EL6,EL7,EL8,EL13,EL14,EL21,EL22,EL29,EL30,EL35,EL36,EL37,EL38,EL39,EL43,EL44,EL45,EL46,EL49,EL50,EL51,EL52,EL58,EL59,EL60,EL61 (28EA)



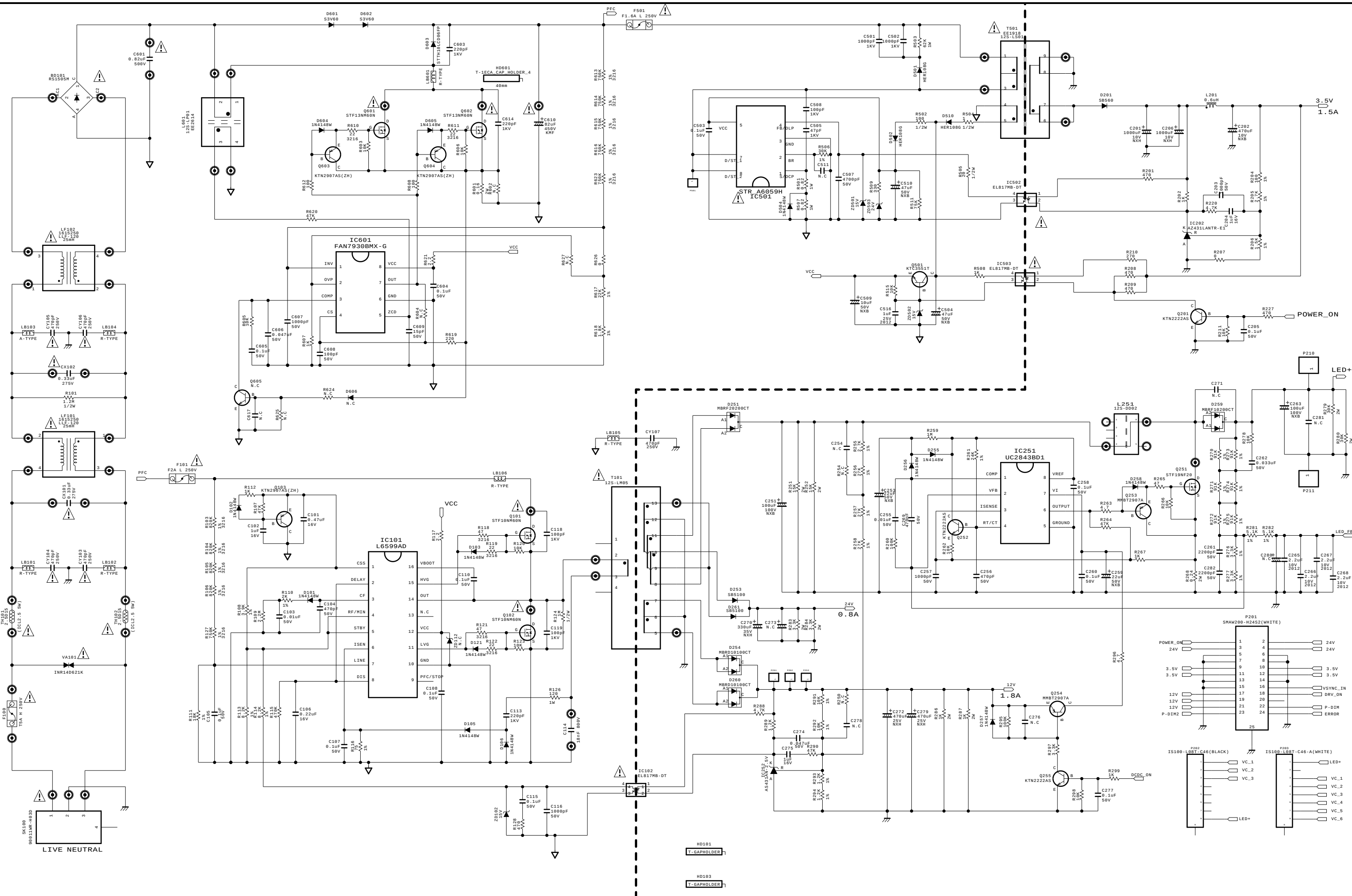
2.14 Electrical Characteristics

No.	Test Item	Test method																		
1	Intermittent Operation stability Test	The switching regulator shall ON/OFF for 20,000 time at an Interval of 10 sec at maximum load, after that electrical Characteristics shall be satisfied.																		
2	Low temperature operation	The switching regulator is left at the operating guarantee Minimum temperature for 2 hours without applying electricity. After that power shall be turned on, and then the electrical Characteristics shall be satisfied.																		
3	Low temperature Storage test Leave At low temperature	The switching regulator is left at minimum storage Temperature for 96 hours or more. Then the switching regulator is left at a room temperature and humidity for 1 hour or more, after that electrical characteristics shall be satisfied.																		
4	Heat cycle storage test	The switching regulator is 10 consecutive temperature cycle that shown below is performed and then leave them at room temperature and humidity for 1 hour or more. After that, electrical characteristics shall be satisfied. <table><tr><th>Time</th><th>Temperature</th></tr><tr><td>30 minutes</td><td>25℃</td></tr><tr><td>30 minutes</td><td>25℃ -> -20℃</td></tr><tr><td>60 minutes</td><td>Minimum storage temperature (-20℃)</td></tr><tr><td>30 minutes</td><td>-20℃ -> 25℃</td></tr><tr><td>30 minutes</td><td>25℃</td></tr><tr><td>30 minutes</td><td>25℃ -> 70℃</td></tr><tr><td>60 minutes</td><td>Maximum storage temperature (70℃)</td></tr><tr><td>30 minutes</td><td>70℃ -> 25℃</td></tr></table>	Time	Temperature	30 minutes	25℃	30 minutes	25℃ -> -20℃	60 minutes	Minimum storage temperature (-20℃)	30 minutes	-20℃ -> 25℃	30 minutes	25℃	30 minutes	25℃ -> 70℃	60 minutes	Maximum storage temperature (70℃)	30 minutes	70℃ -> 25℃
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30 minutes	-20℃ -> 25℃																			
30 minutes	25℃																			
30 minutes	25℃ -> 70℃																			
60 minutes	Maximum storage temperature (70℃)																			
30 minutes	70℃ -> 25℃																			
5	Heat shock test	Heat shock test performed under following conditions without applying electricity and then leave them at room temperature and humidity for 1 hour or more. After that, electrical characteristics shall be satisfied. Condition : -45℃ (30minutes), 120℃ (30minutes), Switching time : Less than 5 minutes, 200 cycles.																		

2.15 Mechanical Characteristics

No.	Test Item	Test method
1	Appearance	There shall be no contaminant or dirt on the switching regulator which has adverse effect on electrical characteristics. There shall be no excessive unevenness or scratches on the plated or painted surface.
2	Vibration	While applying electricity : Vibration frequency : 5 ~ 100Hz Acceleration : 4.9 m/s ² Vibration in X,Y,Z direction for 30 minutes While applying electricity : Vibration frequency : 5 ~ 100Hz Acceleration : 14.7 m/s ² Vibration in X,Y,Z direction for 30 minutes After that electrical characteristics shall be satisfied. There shall be no damage to appearance and construction.
3	Shock	Shock : 98 m/s ² On the oak more than 10mm thickness with the flat face, raise the one side for 50mm, and it carries out each side free fall for three sides. There shall be no damage to appearance and construction.

Schematic Diagram



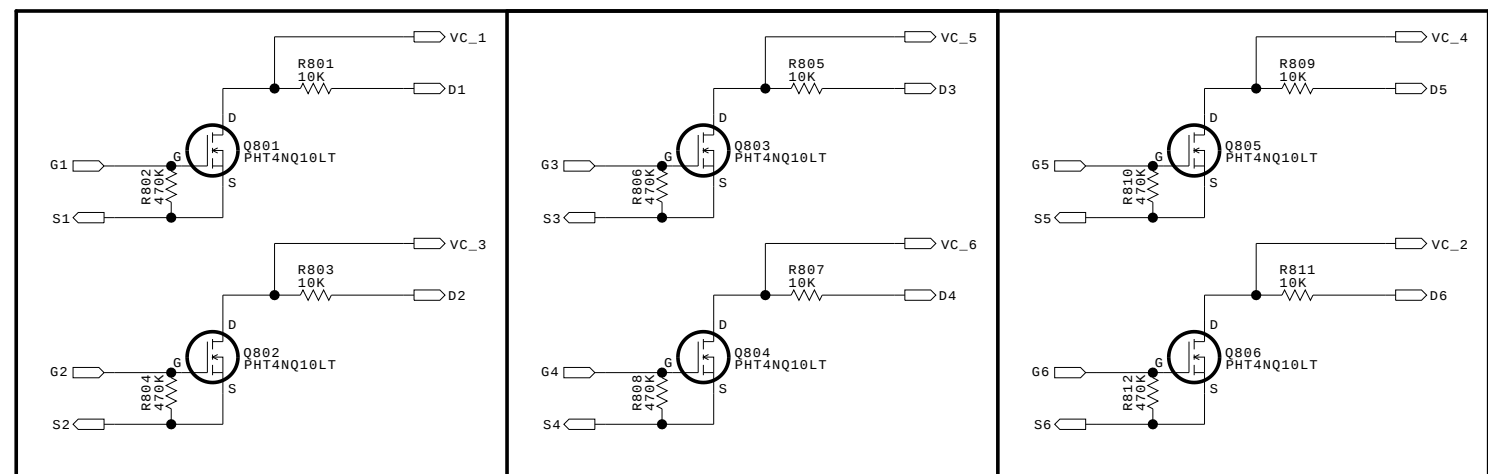
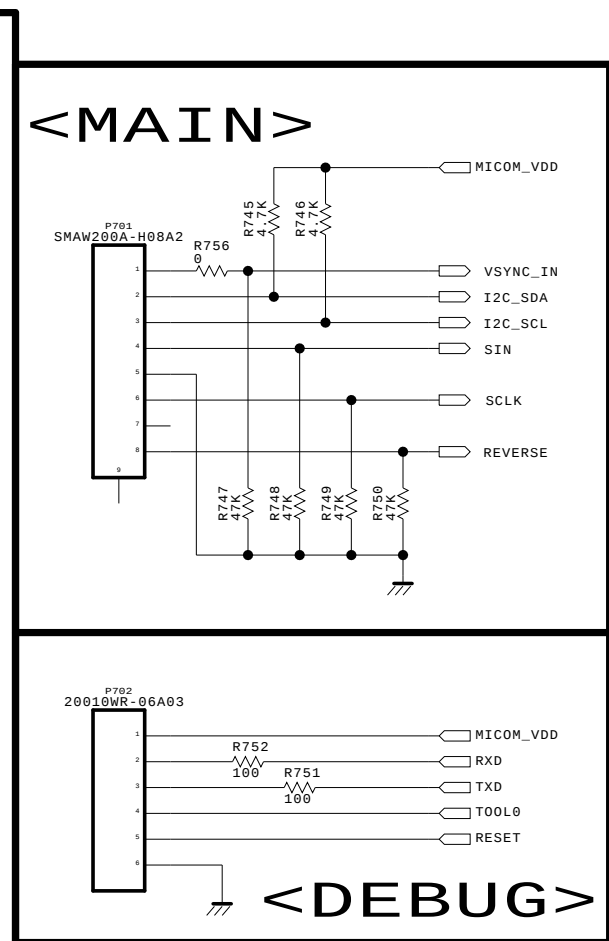
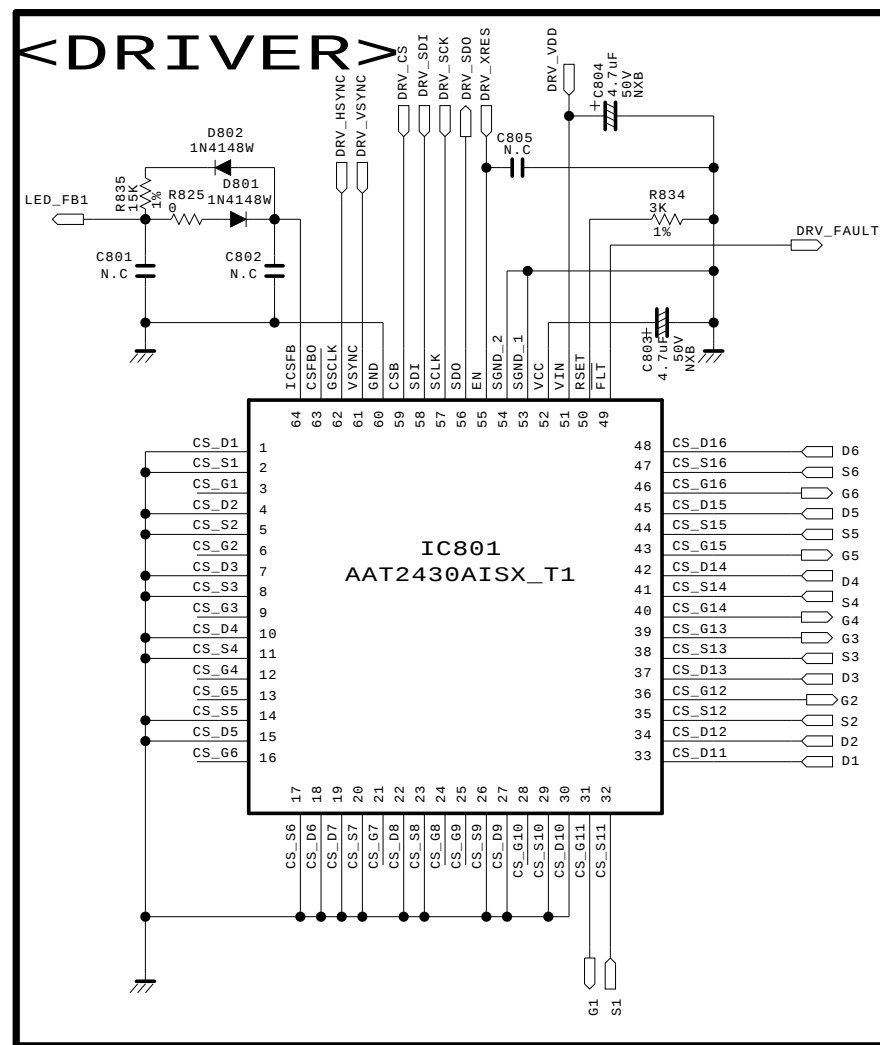
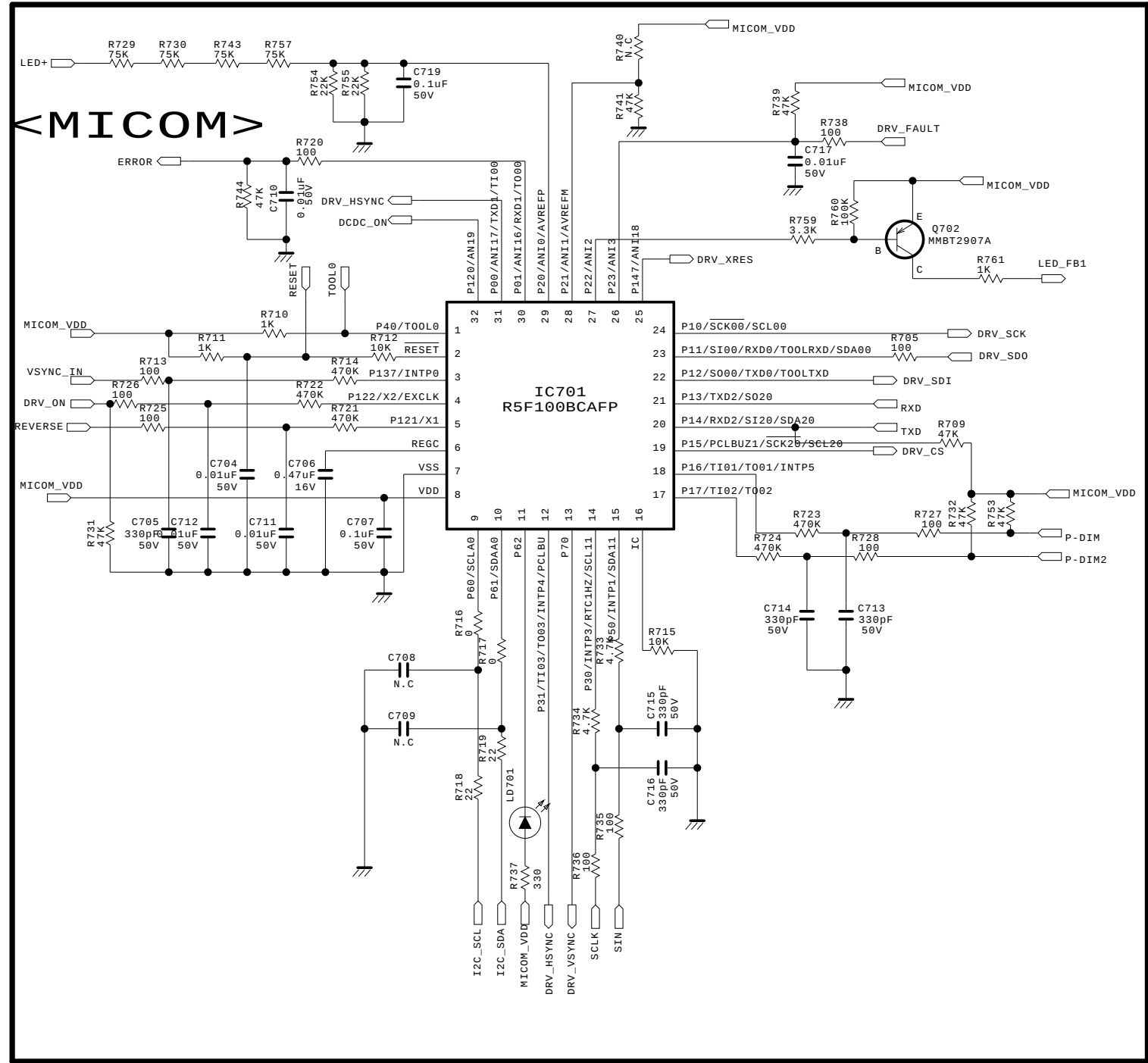
THE  SYMBOL MARK OF THIS SCHEMATIC DIAGRAM INCORPORATES SPECIAL FEATURES IMPORTANT FOR PROTECTION FROM X-RADIATION. FILRE AND ELECTRICAL SHOCK HAZARDS, WHEN SERVICING IF IS ESSENTIAL THAT ONLY MANUFACTURES SPECIFIED PARTS BE USED FOR THE CRITICAL COMPONENTS IN THE  SYMBOL MARK OF THE SCHEMATIC.

SECRET
LGElectronics



MODEL	LGP4247L-12LPB-3PM	DATE	'12.10.09
BLOCK	PFC\STBY\MULTI	SHEET	1 / 2

REV 2.0



THE ⚠ SYMBOL MARK OF THIS SCHEMATIC DIAGRAM INCORPORATES SPECIAL FEATURES IMPORTANT FOR PROTECTION FROM X-RADIATION. FILM AND ELECTRICAL SHOCK HAZARDS, WHEN SERVICING IF IS ESSENTIAL THAT ONLY MANUFACTURES SPECIFIED PARTS BE USED FOR THE CRITICAL COMPONENTS IN THE ⚠ SYMBOL MARK OF THE SCHEMATIC.

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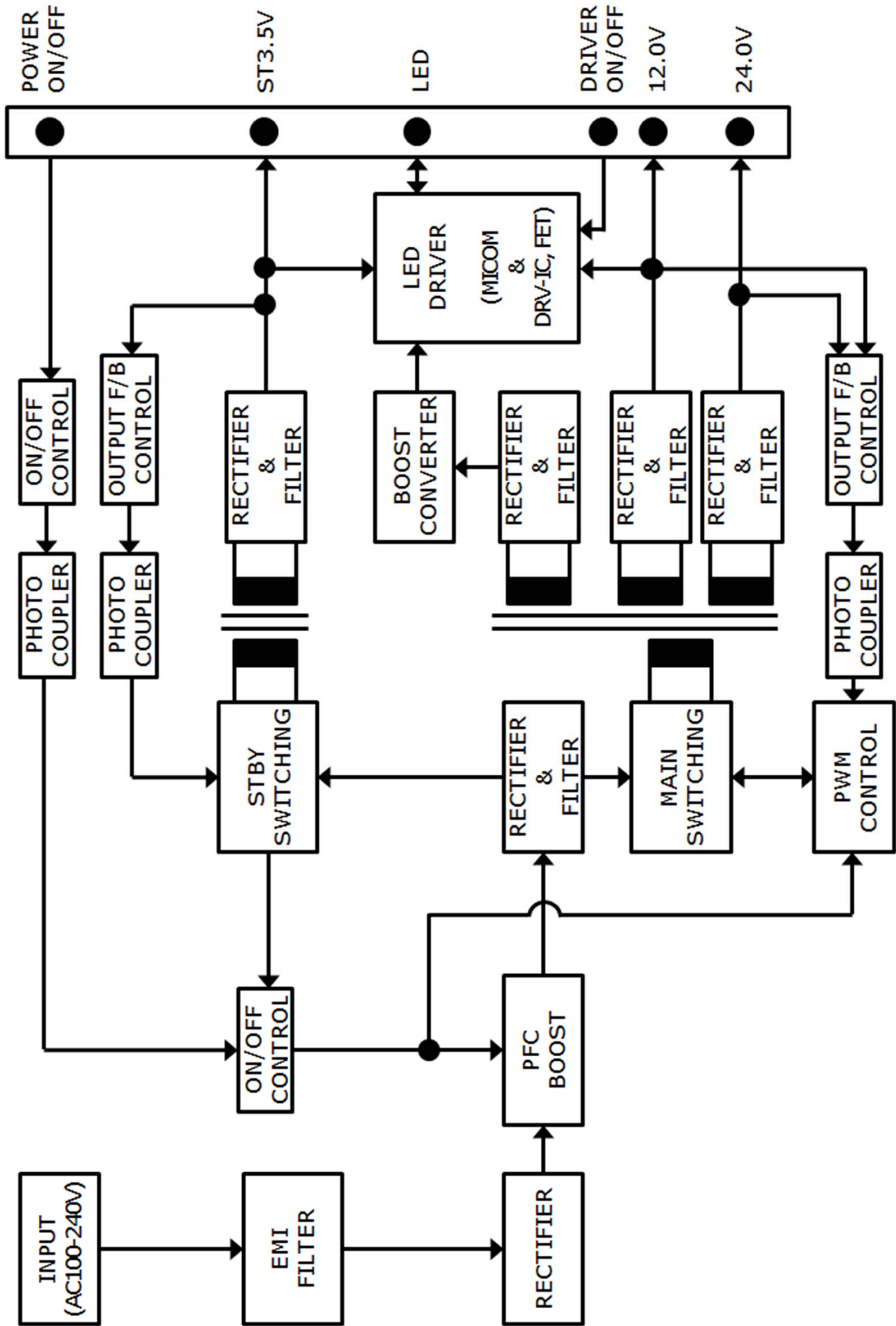
LG Electronics



REV 2.0

MODEL	LGP4247L-12LPB-3PM	DATE	'12.10.09
BLOCK	DRV	SHEET	2 / 2

Block Diagram



Parts List

No	Level	Q'ty	Unit	Location	Specification	Description	Maker
1	MI	1	EA	HS1	MULTI DIODE ASS'Y	HEAT SINK ASS'Y	
2	MI	1	EA	HS1	LPB4247_55_Low HS1 (20 X 40 X 8mm)	HEAT SINK	CHENG CHIA MINGXUE YAO FENG BAO CHENG INNO D&C YUWON NRT HUA GUANG HUA PENG GUOTAI Ohsung Pampas
3	MI	1	EA	D251	MBRF20200CT 20A 200V TO-220FP MBRF20U200CT 20A 200V TO-220FP	DIODE	SENSITRON KEC
4	MI	1	EA	Q251	STF19NF20 200V 15A TO-220FP TK15A20D 200V 15A TO-220FP	FET	STM TOSHIBA
5	MI	2	EA	FOR D251,Q251	M/S S/W + Φ3.0 7L SILVER PLATE HEAD	SCREW	JUNGWOO SEOUL METAL ASIA BOLT SUNG HO METAL KUOFEI HUIYU MACHINERY DELIKANG DONG HAIKANG RUI YOU TANJIN METAL
6	MI	0.5	GR	FOR D251,Q251	HC300 OKC-5500 G746 YG6111 DS-323 AK100 AK100 KD-3	SILICON GREASE	CHANG AMLS OKONG SHINETSU MOMENTIVE DONGYANG SILICON SUNNICO TAIZBOND SHIN WEI
7	MI	1	EA	HS2	PFC FET ASS'Y	HEAT SINK ASS'Y	
8	MI	1	EA	HS2	LPB4247_55_Low HS2 (25 X 28 X 5.5mm)	HEAT SINK	CHENG CHIA MINGXUE YAO FENG BAO CHENG INNO D&C YUWON NRT HUA GUANG HUA PENG GUOTAI Ohsung Pampas
9	MI	2	EA	Q601,Q602	IPA60R280E6 650V 13.8A TO-220FP STF13NM60N 650V 11A TO-220FP	FET	INFINEON STM
10	MI	2	EA	FOR Q601,Q602	M/S S/W + Φ3.0 7L SILVER PLATE HEAD	SCREW	JUNGWOO SEOUL METAL ASIA BOLT SUNG HO METAL KUOFEI HUIYU MACHINERY DELIKANG DONG HAIKANG RUI YOU TANJIN METAL
11	MI	0.5	GR	FOR Q601,Q602	HC300 OKC-5500 G746 YG6111 DS-323 AK100 AK100 KD-3	SILICON GREASE	CHANG AMLS OKONG SHINETSU MOMENTIVE DONGYANG SILICON SUNNICO TAIZBOND SHIN WEI
12	MI	1	EA		LGP4247L-12LPB-3P MI & AI COMPONENTS	MI & AI ASS'Y	
13	MI	1	EA	BD101	TS15P05G 600V 15A L-FORMING RS1505M 600V 15A L-FORMING GBJ1506 600V 15A L-FORMING D15SB60 600V 15A L-FORMING	BRIDGE-DIODE	TSC RECTRON LITE-ON DACHANG
14	MI	1	EA	C610	KMF 82uF 450V M P7.5 Φ18x31.5 SK 82uF 450V M P7.5 Φ18x32	CAPACITOR, ALUMINUM	SAMYOUNG SUSCON
15	MI	2	EA	C251,C263	NXB 100uF 100V M RB P5 Φ12.5x20 MF 100uF 100V M RB P5 Φ13x21	CAPACITOR, ALUMINUM	SAMYOUNG SUSCON
16	MI	1	EA	C601	MPHB 0.82uF 500V J P15 MP 0.82uF 500V J P15 PCMP 372/472 0.82uF 500V J P15	CAPACITOR, FILM	EUROPTRONIC LUMEN PILKOR
17	MI	1	EA	C114	MPLB 0.018uF 1000V J P15 NP 0.018uF 800V J P15 PCMP 384 0.018uF 800V J P15	CAPACITOR, FILM	EUROPTRONIC LUMEN PILKOR
18	MI	2	EA	CX101,CX102	PCX2 337 0.33uF 275V K P15 MPX 0.33uF 275V K P15 CTX 0.33uF 275V K P15	CAPACITOR, FILM	PILKOR EUROPTRONIC CHENG TUNG
19	MI	2	EA	D601,D602	1N5408G 1KV 3A P20 S3V60 600V 3.5A P20 30PDA60 600V 3A P20	DIODE	TSC SHINDENGEN NI
20	MI	1	EA	D603	STTH10LCD06 600V 10A TO-220FP BYV29FX-600 600V 9A TO-220FP	DIODE	STM NXP

21	MI	1	EA	D259	MBRF10U200CT 10A 200V TO-220FP MBRF10200CT 10A 200V TO-220FP FMX-22S 10A 200V TO-220FP	DIODE	KEC SENSITRON SANKEN
22	MI	2	EA	D253,D261	SB5100 100V 5A P20 SR510-24 100V 5A P20 SB5100 100V 5A P20	DIODE	SENSITRON TSC LITE-ON
23	MI	1	EA	D201	SB560 60V 5A P20 SR560 60V 5A P20 SB560 60V 5A P20	DIODE	SENSITRON DACHANG LITE-ON
24	MI	2	EA	Q101,Q102	TK10A60D 600V 10A TO-220FP L-FORMING STF10NM60N 650V 8A TO-220FP L-FORMING KF12N60F 600V 12A TO-220FP L-FORMING SD10N60C3 600V 10A TO-220FP L-FORMING	FET	TOSHIBA STM KEC INFINEON
25	MI	1	EA	F100	T5A H 250V 215 RED(1-LINE) T5A H 250V 50CT RED(1-LINE) T5A H 250V TSC RED(1-LINE)	FUSE, TIME LAG	LITTELFUSE DAIN WALTER
26	MI	4	EA	PG1,PG2,PG3,PG4	JS-12-75-04 SPCC 0.4T GND PIN	GND REINFORCE	SAMSUNG JS ST TELECOM PINGOOD DIHUA HUAKANG KANG YAUNG
28	MI	3	EA	IC102,IC502,IC503	EL817M(DT) B LTV817M-BN	IC	EVERLIGHT LITE-ON
29	MI	1	EA	IC501	STR-A6059H DIP-8	IC	SANKEN
30	MI	2	EA	TH101,TH102	ICL-5W 2R50MSMT DSC2.5D15 2.5Ω 8A Φ15 MF72-2.5D15 2.5Ω 7A Φ15 WTR15D2R5 2.5Ω 8A Φ15	ICL THERMISTOR THERMISTOR THERMISTOR	SMART DSC NSE WMEC
31	MI	1	EA	L201	0.6uH Φ3X10L BAR	INDUCTOR, COIL	DONGYANG TELECOM SOOJUNG CLOVER FEELUX LIENCHANG
32	MI	1	EA	L251	12S-DD02	INDUCTOR, COIL	SOOJUNG JIANGSU CHANNELON ELECTRONIC GROUP FEELUX DONGYANG TELECOM BUJEON LIENCHANG
33	MI	2	EA	LF101,LF102	CS610250S 25mH LT6010250 25mH LLF-120 25mH LLF-120 25mH	LINE FILTER	TNC DONG IL DONGYANG TELECOM FEELUX
34	MI	1	EA	HD601	EC40.0CAP-F-12	MAIN CAP HOLDER	TBI
35	MI	1	EA	T101	12S-LM05	TRANSFORMER	TDK SOOJUNG JIANGSU CHANNELON ELECTRONIC GROUP DONGYANG TELECOM BUJEON LIENCHANG FEELUX LGIT
36	MI	1	EA	L601	12S-LP01	TRANSFORMER	TDK SOOJUNG JIANGSU CHANNELON ELECTRONIC GROUP DONGYANG TELECOM BUJEON LIENCHANG FEELUX LGIT
37	MI	1	EA	T501	12S-LS01	TRANSFORMER	TDK SOOJUNG JIANGSU CHANNELON ELECTRONIC GROUP DONGYANG TELECOM BUJEON LIENCHANG FEELUX CLOVER
38	MI	1	EA	VA101	INR14D621K-CAP 620V Φ14 L-FORMING TUBE SVC621D-14ATM7 620V Φ14 L-FORMING TUBE WMR14D621 620V Φ14 L-FORMING TUBE	VARISTOR	AMOTECH SAMWHA WMEC
39	MI	1	EA	P702	20010WR-06A03 6PIN WHITE	WAFER	YEONHO
40	MI	1	EA	SK100	90011WR-H03D BLACK	WAFER	YEONHO
41	MI	1	EA	P202	IS100-L08T-C46 8PIN BLACK	WAFER	UJU ELE
42	MI	1	EA	P203	IS100-L08T-C46-A 8PIN WHITE	WAFER	UJU ELE
43	MI	1	EA	P701	SMAW200A-H08A2 8PIN WHITE	WAFER	YEONHO
44	MI	1	EA	SH101	Bracket for LPB4247 Low , 27.8L*6.0W*7.2H, SPCC 0.8t	Bracket	CHENG CHIA MINGXUE YAOFENG BAOCHENG INNO D&C YUWON NRT HUA GUANG HUA PENG GUOTAI Ohsung Pampas
45	MI	1	EA	P201	SMAW200-H24S2 24PIN WHITE	WAFER	YEONHO
46	SMT	1	EA	LGP4247L-12LPB-3P SMT COMPONENTS			
47	SMT	1	EA	LB701	CB1608GK102T JCBH160808A102	BEAD	SAMWHA JOINSET
48	SMT	1	EA	C609	15pF 50V J 1608 COG	CAPACITOR, CHIP	MURATA PILKOR SAMWHA TAIYO UDEN TDK YAGEO HEC
49	SMT	1	EA	C608	100pF 50V J 1608 COG	CAPACITOR, CHIP	
50	SMT	5	EA	C705,C713,C714,C715,C716	330pF 50V J 1608 COG	CAPACITOR, CHIP	
51	SMT	3	EA	C104,C256,C269	470pF 50V J 1608 COG	CAPACITOR, CHIP	
52	SMT	4	EA	C116,C203,C257,C607	0.001uF 50V K 1608 X7R	CAPACITOR, CHIP	
53	SMT	2	EA	C261,C282	0.0022uF 50V K 1608 X7R	CAPACITOR, CHIP	
54	SMT	1	EA	C507	0.0047uF 50V K 1608 X7R	CAPACITOR, CHIP	

55	SMT	7	EA	C103,C255,C704,C710,C711,C712,C717	0.01uF 50V K 1608 X7R	CAPACITOR, CHIP	MURATA PILKOR SAMWHA TAIYOYUDEN TDK YAGEO HEC
56	SMT	1	EA	C262	0.033uF 50V K 1608 X7R	CAPACITOR, CHIP	
57	SMT	2	EA	C274,C606	0.047uF 50V K 1608 X7R	CAPACITOR, CHIP	
58	SMT	16	EA	C105,C107,C108,C110,C115,C205,C258,C260,C277,C503,C604,C605,C701,C702,C707,C719	0.1uF 50V K 1608 X7R	CAPACITOR, CHIP	MURATA TDK
59	SMT	1	EA	C106	0.22uF 16V K 1608 X7R	CAPACITOR, CHIP	
60	SMT	2	EA	C101,C706	0.47uF 16V K 1608 X7R	CAPACITOR, CHIP	
61	SMT	3	EA	C102,C204,C275	1uF 16V K 1608 X7R	CAPACITOR, CHIP	MURATA TDK
62	SMT	1	EA	C516	1uF 25V K 2012 X7R or 1uF 50V K 2012 X7R(PILKOR 삭제)	CAPACITOR, CHIP	
63	SMT	4	EA	C265,C266,C267,C268	2.2uF 10V K 2012 X7R or 2.2uF 16V K 2012 X7R	CAPACITOR, CHIP	
64	SMT	15	EA	D101,D102,D103,D105,D106,D121,D255,D256,D257,D258,D504,D604,D605,D801,D802	1N4148W 100V 150mA SOD-123 1N4148W 100V 150mA SOD-123 MMSD4148T1 100V 200mA SOD-123 SDS4148G 100V 150mA SOD-123	DIODE	RECTRON DIODES ONSEMI AUK
65	SMT	2	EA	D254,D260	MBRD10100CT 10A 100V D-PACK MBRD10U100CT 10A 100V D-PACK SPEN-210A 10A 100V D-PACK	DIODE	SENSITRON KEC SANKEN
66	SMT	6	EA	Q801,Q802,Q803,Q804,Q805,Q806	PHT4NQ10LT 100V 3.5A SOT-223 MDHT4N20Y 200V 0.85A SOT-223 STN4NF20L 200V 3.2A SOT-223	FET	NXP MAGNACHIP STM
67	SMT	1	EA	IC101	L6599AD SO-16N	IC	STM
68	SMT	1	EA	IC202	SJ432BS 1.24V ±0.5% SOT-23 TLV431BSN1T1G, 1.24V±0.5%, SOT-23 AZ431LANTR-E1, 1.24V±0.5%, SOT-23	IC	AUK ON SEMI BCD
69	SMT	1	EA	IC251	UC2843B SO-8 AP3843CM SO-8 UC2843B SO-8	IC	ONSEMI BCD STM
70	SMT	1	EA	IC252	SNF431BS 2.5V ±0.5% SOT-23 AS431AN, 2.5V±0.5%, SOT-23 KA431SLMF2, 2.5V±0.5%, SOT-23	IC	AUK BCD FAIRCHILD
71	SMT	1	EA	IC601	FAN7930BMX_G SOIC-8	IC	FAIRCHILD
72	SMT	1	EA	IC701	R5F100BCAFP	IC	Renesas
73	SMT	1	EA	IC801	AAT2430AISX_T1	IC	AATI
74	SMT	20	EA	J14,J17,J18,J20,J27,J36,J37,J38,J39,J42,J47,J48,J49,J50,J53,J54,J55,J68,J69,J70	0Ω J 3216	RESISTOR, CHIP	KAMAYA PILKOR ROHM SAMSUNG YAGEO TZAI YUAN
75	SMT	4	EA	R119,R122,R610,R611	22Ω J 3216	RESISTOR, CHIP	
76	SMT	2	EA	R118,R121	47Ω J 3216	RESISTOR, CHIP	
77	SMT	6	EA	R127,R613,R614,R615,R616,R623	750KΩ F 3216	RESISTOR, CHIP	
78	SMT	4	EA	R103,R104,R105,R106	820KΩ F 3216	RESISTOR, CHIP	
79	SMT	6	EA	R207,R626,R716,R717,R756,R825	0Ω J 1608	RESISTOR, CHIP	
80	SMT	1	EA	R289	1.2KΩ J 1608	RESISTOR, CHIP	
81	SMT	3	EA	R260,R295,R760	100KΩ J 1608	RESISTOR, CHIP	
82	SMT	14	EA	R608,R612,R705,R713,R720,R725,R726,R727,R728,R735,R736,R738,R751,R752	100Ω J 1608	RESISTOR, CHIP	
83	SMT	20	EA	R120,R123,R211,R262,R266,R278,R298,R515,R603,R605,R606,R703,R712,R715,R801,R803,R805,R807,R809,R811	10KΩ J 1608	RESISTOR, CHIP	
84	SMT	1	EA	R704	10Ω J 1608	RESISTOR, CHIP	
85	SMT	10	EA	R112,R202,R267,R299,R508,R607,R701,R710,R711,R761	1KΩ J 1608	RESISTOR, CHIP	
86	SMT	1	EA	R259	1MΩ J 1608	RESISTOR, CHIP	
87	SMT	1	EA	R109	2.2MΩ J 1608	RESISTOR, CHIP	
88	SMT	3	EA	R117,R621,R702	2.2Ω J 1608	RESISTOR, CHIP	
89	SMT	2	EA	R718,R719	22Ω J 1608	RESISTOR, CHIP	
90	SMT	1	EA	R619	220Ω J 1608	RESISTOR, CHIP	
91	SMT	2	EA	R754,R755	22KΩ J 1608	RESISTOR, CHIP	
92	SMT	1	EA	R210	270Ω J 1608	RESISTOR, CHIP	
93	SMT	2	EA	R297,R759	3.3KΩ J 1608	RESISTOR, CHIP	
94	SMT	1	EA	R108	3.9KΩ F 1608	RESISTOR, CHIP	
95	SMT	2	EA	R509,R737	330Ω J 1608	RESISTOR, CHIP	
96	SMT	6	EA	R220,R288,R733,R734,R745,R746	4.7KΩ J 1608	RESISTOR, CHIP	
97	SMT	2	EA	R263,R296	4.7Ω J 1608	RESISTOR, CHIP	
98	SMT	12	EA	R115,R714,R721,R722,R723,R724,R802,R804,R806,R808,R810,R812	470KΩ J 1608	RESISTOR, CHIP	
99	SMT	5	EA	R128,R201,R208,R209,R227	470Ω J 1608	RESISTOR, CHIP	
100	SMT	15	EA	R107,R264,R290,R620,R709,R731,R732,R739,R741,R744,R747,R748,R749,R750,R753	47KΩ J 1608	RESISTOR, CHIP	
101	SMT	1	EA	R265	47Ω J 1608	RESISTOR, CHIP	
102	SMT	5	EA	R511,R729,R730,R743,R757	75KΩ J 1608	RESISTOR, CHIP	
103	SMT	2	EA	R293,R294	1.2KΩ F 1608	RESISTOR, CHIP	
104	SMT	1	EA	R206	1.5KΩ F 1608	RESISTOR, CHIP	
105	SMT	1	EA	R618	1.8KΩ F 1608	RESISTOR, CHIP	
106	SMT	1	EA	R204	100Ω F 1608	RESISTOR, CHIP	
107	SMT	2	EA	R291,R292	10KΩ F 1608	RESISTOR, CHIP	
108	SMT	1	EA	R835	15KΩ F 1608	RESISTOR, CHIP	
109	SMT	1	EA	R111	18KΩ F 1608	RESISTOR, CHIP	
110	SMT	2	EA	R205,R255	2.7KΩ F 1608	RESISTOR, CHIP	
111	SMT	1	EA	R617	22KΩ F 1608	RESISTOR, CHIP	
112	SMT	1	EA	R261	24KΩ F 1608	RESISTOR, CHIP	
113	SMT	3	EA	R256,R257,R258	27KΩ F 1608	RESISTOR, CHIP	
114	SMT	1	EA	R110	2KΩ F 1608	RESISTOR, CHIP	
115	SMT	2	EA	R276,R277	3.3KΩ F 1608	RESISTOR, CHIP	
116	SMT	1	EA	R506	30KΩ F 1608	RESISTOR, CHIP	
117	SMT	1	EA	R834	3KΩ F 1608	RESISTOR, CHIP	
118	SMT	2	EA	R281,R282	5.1KΩ F 1608	RESISTOR, CHIP	
119	SMT	1	EA	R116	75Ω F 1608	RESISTOR, CHIP	
120	SMT	2	EA	R113,R114	8.2KΩ F 1608	RESISTOR, CHIP	
121	SMT	6	EA	R270,R271,R272,R273,R274,R275	91KΩ F 1608	RESISTOR, CHIP	
122	SMT	2	EA	HD101,HD103	3X2.45X2.5H	SUPPORTER	POWER VALLEY

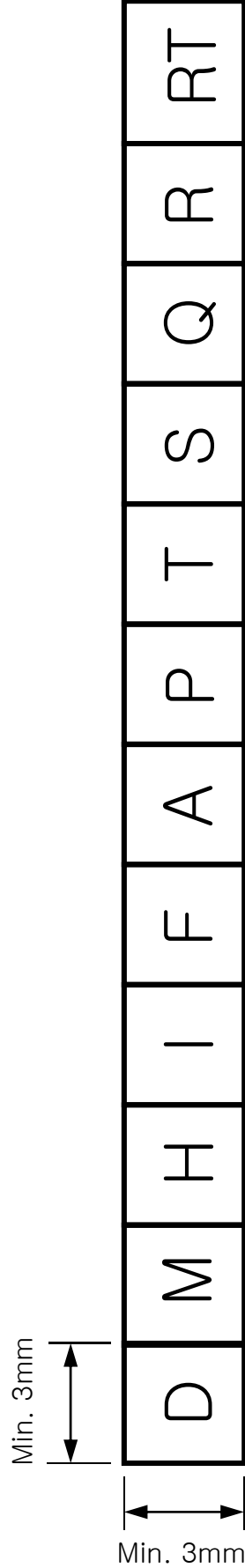
123	SMT	1	EA	Q701	2N7002K 60V 300mA SOT-23 2N7002K 60V 380mA SOT-23 RK7002 60V 115mA SOT-23 SSM3K7002F 60V 200mA SOT-23	TRANSISTOR	DIODES ONSEMI ROHM TOSHIBA
124	SMT	1	EA	Q501	KTC3551T 80V 1A TSM NPN BCW66GLT1 45V 800mA SOT-23 NPN 2SC5865 SOT-23 NPN	TRANSISTOR	KEC ONSEMI ROHM
125	SMT	3	EA	Q201,Q252,Q255	MMBT2222A 40V 600mA SOT-23 NPN KTN2222AS 40V 600mA SOT-23 NPN PMBT2222A 40V 600mA SOT-23 NPN SBT2222A 40V 600mA SOT-23 NPN	TRANSISTOR	ONSEMI KEC NXP AUK
126	SMT	6	EA	Q103,Q253,Q254,Q603,Q604, Q702	MMBT2907A -60V -600mA SOT-23 PNP KTN2907AS -60V -600mA SOT-23 PNP PMBT2907 -60V -600mA SOT-23 PNP SBT2907A -60V -600mA SOT-23 PNP	TRANSISTOR	ONSEMI KEC NXP AUK
127	SMT	0.5	GR		HT-130A-106 HT-130D-7 LOCTITE 3609 NE8800T	BOND (SMD)	HITECH KOREA HITECH KOREA LOCTITE FUJI
128	AI	1	EA		LGP4247L-12LPB-3P AI COMPONENTS		
129	AI	1	EA	C509	NXB 10uF 50V M P5 Φ5X11 SG 10uF 50V M P5 Φ5X11	CAPACITOR, ALUMINUM	SAMYOUNG SUSCON
130	AI	2	EA	C253,C259	NXB 22uF 50V M P5 Φ5X11 SG 22uF 50V M P5 Φ5X11	CAPACITOR, ALUMINUM	SAMYOUNG SUSCON
131	AI	2	EA	C803,C804	NXB 4.7uF 50V M P5 Φ5X11 SG 4.7uF 50V M P5 Φ5X11	CAPACITOR, ALUMINUM	SAMYOUNG SUSCON
132	AI	1	EA	C202	NXB 470uF 10V M P5 Φ8X11.5 SG 470uF 10V M P5 Φ8X12	CAPACITOR, ALUMINUM	SAMYOUNG SUSCON
133	AI	2	EA	C504,C510	NXB 47uF 50V M P5 Φ6.3X11 SG 47uF 50V M P5 Φ6.3X11	CAPACITOR, ALUMINUM	SAMYOUNG SUSCON
134	AI	2	EA	C201,C206	NXH 1000uF 10V M P5 Φ10X12.5 MG 1000uF 10V M P5 Φ10X13	CAPACITOR, ALUMINUM	SAMYOUNG SUSCON
135	AI	1	EA	C270	NXH 330uF 35V M P5 Φ10X12.5 MG 330uF 35V M P5 Φ10X13	CAPACITOR, ALUMINUM	SAMYOUNG SUSCON
136	AI	2	EA	C272,C279	NXH 470uF 25V M P5 Φ10X12.5 MG 470uF 25V M P5 Φ10X13	CAPACITOR, ALUMINUM	SAMYOUNG SUSCON
137	AI	3	EA	C113,C603,C614	DG 220pF 1KV K P5 125℃ CK 220pF 1KV K P5 125℃ CT81 220pF 1KV K P5 125℃ CK45 220pF 1KV K P5 125℃	CAPACITOR, CERAMIC	APEX INTEC DONGIL ELEC. YINANDON TDK
138	AI	3	EA	C118,C119,C508	DG 100pF 1KV K P5 125℃ CK 100pF 1KV K P5 125℃ CT81 100pF 1KV K P5 125℃ CK45 100pF 1KV K P5 125℃	CAPACITOR, CERAMIC	APEX INTEC DONGIL ELEC. YINANDON TDK
139	AI	1	EA	C505	DG 47pF 1KV K P5 125℃ CC 47pF 1KV K P5 125℃ CC81 47pF 1KV K P5 125℃ CC45 47pF 1KV K P5 125℃	CAPACITOR, CERAMIC	APEX INTEC DONGIL ELEC. YINANDON TDK
140	AI	2	EA	C501,C502	DG 1000pF 1KV K P5 125℃ CK 1000pF 1KV K P5 125℃ CT81 1000pF 1KV K P5 125℃ CK45 1000pF 1KV K P5 125℃	CAPACITOR, CERAMIC	APEX INTEC DONGIL ELEC. YINANDON TDK
141	AI	5	EA	CY103,CY104,CY105,CY106,CY107	DA 470pF 400V K P10 105℃ DA 470pF 400V K P10 105℃ CT81 470pF 400V K P10 105℃ CD 470pF 400V K P10 105℃	CAPACITOR, CERAMIC	APEX INTEC DONGIL ELEC. YINANDON TDK
142	AI	3	EA	D501,D502,D510	UF1007 1KV 1A DO-41 UF4007 1KV 1A DO-41 HER108G 1KV 1A DO-41 UF4007 1KV 1A DO-41	DIODE	DIODES DACHANG RECTRON TSC
143	AI	3	EA	ZD102,ZD501,ZD502	1N5245B 15V DO-35 1N5245B 15V DO-35 MTZJ15B 15V DO-34	DIODE, ZENER	VISHAY RECTRON ROHM
144	AI	1	EA	ZD503	1N5252B 24V DO-35 1N5252B 24V DO-35 MTZJ24B 24V DO-34	DIODE, ZENER	VISHAY RECTRON ROHM
145	AI	28	EA	EL3,EL4,EL6,EL7,EL8,EL13, EL14,EL21,EL22,EL29,EL30, EL35,EL36,EL37,EL38,EL39, EL43,EL44,EL45,EL46,EL49, EL50,EL51,EL52,EL58,EL59, EL60,EL61	1.6X3.0	EYELET	SAMSUNG JS DOSUNG DAERIN HUAKANG DELKANG SEJIN LEZHI Avico
146	AI	21	EA	EL1, EL2, EL5,EL9, EL10, EL11,EL12,EL15,EL16,EL17, EL18,EL19,EL20,EL23,EL24, EL25,EL26,EL31,EL32,EL33, EL34,	2.0X3.0	EYELET	SAMSUNG JS DOSUNG DAERIN HUAKANG DELKANG SEJIN LEZHI Avico
147	AI	1	EA	F501	F1.6A L 250V 876	FUSE, FAST ACTING	LITTELFUSE
148	AI	1	EA	F101	F2A L 250V 876	FUSE, FAST ACTING	LITTELFUSE
149	AI	6	EA	P210,P211,P251,P252,P253,P501	SSJS236-6-3 (6mm Under)	GT PIN	SAMSUNG JS DOSUNG DAERIN HUAKANG DELKANG SEJIN LEZHI Avico
150	AI	7	EA	LB101,LB102,LB103,LB104,LB105,LB106, LB601	BFS3550R2F SINGLE RADIAL SER3550050BA SINGLE RADIAL	INDUCTOR, BEAD FILTER LEAD	SAMWHA SCC

152	AI	39	EA	J1, J3, J4, J5, J6, J7, J8, J9, J10, J11, J12, J13, J15, J16, J19, J21, J22, J23, J24, J25, J28, J29, J30, J31, J32, J33, J34, J35, J40, J41, J43, J44, J45, J46, J51, J59, J65, J66, J67	Φ0.6	JUMPER WIRE	DIELEC DAPcsLPcsD TPI TZAI YUAN UNI-OHM ILKWANG DM Seungwon RLC
153	AI	1	EA	LD701	LTL-1CHY-001A, 5mm Pitch Type (Yellow) 204-10UYC-S530, 5mm Pitch Type (Yellow)	LED	LITE-ON EVERLIGHT
154	AI	1	EA	R502	CRS 100Ω 1/2W J SMALL RDM92 100Ω 1/2W J SMALL SFR25H 100Ω 1/2W J SMALL CF 100Ω 1/2W J SMALL	RESISTOR, CARBON FILM	ABCO SMART PILKOR TZAI YUAN
155	AI	1	EA	R504	CRS 1Ω 1/2W J SMALL RDM92 1Ω 1/2W J SMALL SFR25H 1Ω 1/2W J SMALL CF 1Ω 1/2W J SMALL	RESISTOR, CARBON FILM	ABCO SMART PILKOR TZAI YUAN
156	AI	1	EA	R505	CRS 20Ω 1/2W J SMALL RDM92 20Ω 1/2W J SMALL SFR25H 20Ω 1/2W J SMALL CF 20Ω 1/2W J SMALL	RESISTOR, CARBON FILM	ABCO SMART PILKOR TZAI YUAN
157	AI	1	EA	R101	PRC 1.2MΩ 1/2W J SURGE MSR37 1.2MΩ 1/2W J SURGE	RESISTOR, FIXED CARBON COMPOSITION	SMART PILKOR
158	AI	1	EA	R124	PRC 1MΩ 1/2W J SURGE MSR37 1MΩ 1/2W J SURGE	RESISTOR, FIXED CARBON COMPOSITION	SMART PILKOR
159	AI	2	EA	R251, R252	MORS 15KΩ 2W J SMALL RSD02 15KΩ 2W J SMALL PR02 15KΩ 2W J SMALL MOF 15KΩ 2W J SMALL	RESISTOR, METAL OXIDE FILM	ABCO SMART PILKOR TZAI YUAN
160	AI	1	EA	R126	MORS 120Ω 1W J SMALL RSD01 120Ω 1W J SMALL PR01 120Ω 1W J SMALL MOF 120Ω 1W J SMALL	RESISTOR, METAL OXIDE FILM	ABCO SMART PILKOR TZAI YUAN
161	AI	2	EA	R286, R287	MORS 1KΩ 2W J SMALL RSD02 1KΩ 2W J SMALL PR02 1KΩ 2W J SMALL MOF 1KΩ 2W J SMALL	RESISTOR, METAL OXIDE FILM	ABCO SMART PILKOR TZAI YUAN
162	AI	2	EA	R279, R280	MORS 30KΩ 2W J SMALL RSD02 30KΩ 2W J SMALL PR02 30KΩ 2W J SMALL MOF 30KΩ 2W J SMALL	RESISTOR, METAL OXIDE FILM	ABCO SMART PILKOR TZAI YUAN
163	AI	2	EA	R283, R284	MORS 3.3KΩ 2W J SMALL RSD02 3.3KΩ 2W J SMALL PR02 3.3KΩ 2W J SMALL MOF 3.3KΩ 2W J SMALL	RESISTOR, METAL OXIDE FILM	ABCO SMART PILKOR TZAI YUAN
164	AI	1	EA	R503	MORS 62KΩ 1W J SMALL RSD01 62KΩ 1W J SMALL PR01 62KΩ 1W J SMALL MOF 62KΩ 1W J SMALL	RESISTOR, METAL OXIDE FILM	ABCO SMART PILKOR TZAI YUAN
165	AI	2	EA	R501, R507	WNPS 0.82Ω 1W J SMALL PRN 0.82Ω 1W J SMALL	RESISTOR, WIRE WOUND	ABCO SMART
166	AI	1	EA	R601	WNPS 0.16Ω 2W J SMALL PRN 0.16Ω 2W J SMALL	RESISTOR, WIRE WOUND	ABCO SMART
167	AI	1	EA	R268	WNPS 0.24Ω 2W J SMALL PRN 0.24Ω 2W J SMALL	RESISTOR, WIRE WOUND	ABCO SMART
168	AI	1	EA		EAX64744204 176 x 245 1.6T FR1 KB, DS, L, R-8700 CTI-600	PCB	DUCK SUNG HT CIRCUIT(QINGDAO) DONGMYUNG CIR SHANGHAI WANZHENG SHENG KHUANG NEW TRIUNION TIANJIN DEA DUCK HUIHO HSIANG KUO TIAN FENG TIS KOREA Wellbest Cosmotech Kyosha
169	ETC				SUBSIDIARY MATERIALS		
170	ETC	0.0625	EA		509 * 344 * 204 * 8T	BOX CARTON	NEWEA IND DAESAN. HANYOUNG JAEIL QXBW TAILI PACKING HUA XING PACK SOONGSAN WUJIANG ZHENLONG SUZHOU JIADELONG KUNSHAN KUNHONG Dongju

171	ETC	0.5625	EA		341 * 180 * 8T (Cross board A)	BOX PARTITION	NEWEA IND DAESAN. HANYOUNG JAEIL QXBW TAILI PACKING HUA XING PACK SOONGSAN WUJIANG ZHENLONG SUZHOU JIADELONG KUNSHAN KUNHONG Dongju
172	ETC	0.3125	EA		506 * 180 * 8T (Cross board B)	BOX PARTITION	NEWEA IND DAESAN. HANYOUNG JAEIL QXBW TAILI PACKING HUA XING PACK SOONGSAN WUJIANG ZHENLONG SUZHOU JIADELONG KUNSHAN KUNHONG Dongju
173	ETC	0.1875	EA		506 * 341 * 8T	PAD	NEWEA IND DAESAN. HANYOUNG JAEIL QXBW TAILI PACKING HUA XING PACK SOONGSAN WUJIANG ZHENLONG SUZHOU JIADELONG KUNSHAN KUNHONG Dongju
174	ETC	1	EA		Min 460 * 180	BUBBLE SHEET	DUCKJIN S&P JAEIL QXBW CHUMDAN A-TEK KUNSHANKUNHONG LIYUANG SERVEONE
175	ETC	1	EA		42 X 8 NY WHITE 93CODE 19DIGIT	BAR CODE	SHUN JIN HANA. AIT SERVEONE WUJIANG SUNGLING GUNGAOQI ZHI XIN
176	ETC	1	EA		19 X 9 NY WHITE MICOM CHECKSUM	LABEL	SHUN JIN HANA. AIT SERVEONE WUJIANG SUNGLING GUNGAOQI ZHI XIN
177	ETC	12.0	GR		EF-9301(g) ILF-714(kg) TF328-2-2(Kg) EC-19S-8 CS-9111LF	FLUX	ALPHA ION ELEC TONGFANG 동 화 다 무 라 청 솔
178	ETC	20.0	GR		HSE-11 B20 BAR (SN:99%,AG:0.3%,CU:0.7%) SN:99%, AG:0.3%, CU:0.7% SAC0307 A+ SN:99%, AG:0.3%, CU:0.7% YW9-0307 SN:99%, AG:0.3%, CU:0.7% M35E-BAR SN:99%, AG:0.3%, CU:0.7%	SOLDER BAR	HEESUNG METAL SEOUL ALLOYMETAL DYFENCO YUNNAN TIN SOLNET
179	ETC	5.0	GR		HSE-11 B20 BAR (SN:99%,AG:0.3%,CU:0.7%) SN:99%, AG:0.3%, CU:0.7% SAC0307 A+ SN:99%, AG:0.3%, CU:0.7% YW9-0307 SN:99%, AG:0.3%, CU:0.7% M35E-BAR SN:99%, AG:0.3%, CU:0.7%	SOLDER WIRE	HEESUNG METAL SEOUL ALLOYMETAL DYFENCO YUNNAN TIN SOLNET
180	ETC	10.0	GR		H-828W OKE-410 QS9112 RTV SS7945W TSE3854DS-W BN707 RTV KE402RTV ES 2044H & 2S2482W UB-5601 EA-4100 DS-818	BOND (RTV)	OKONG OKONG KCC KCC MOMENTIVE BONIC SHINETSU CANADA U-BOND DOW CORNING DONGYANG

Process Marking

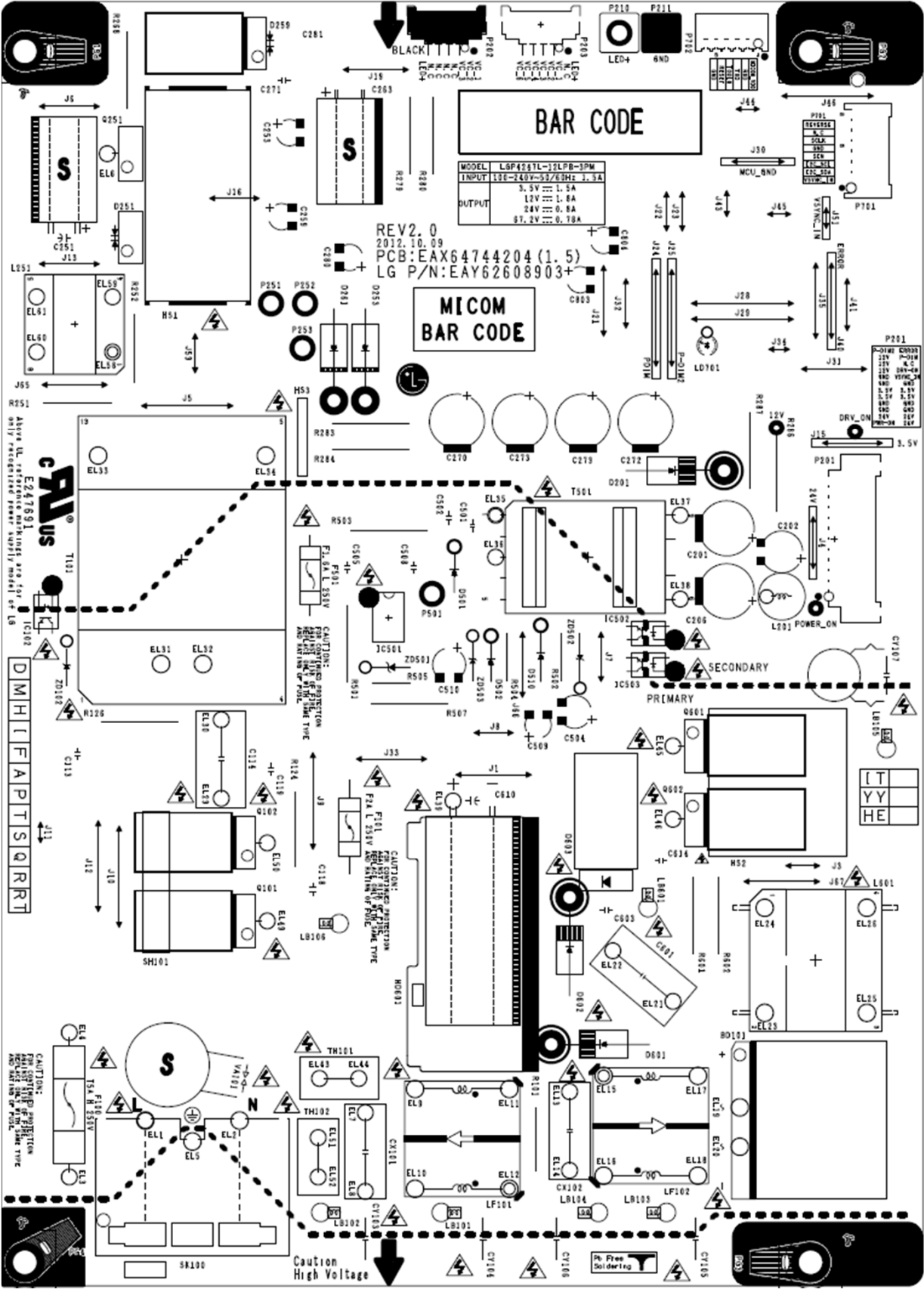
공정표시 MARK (PCB SILK)



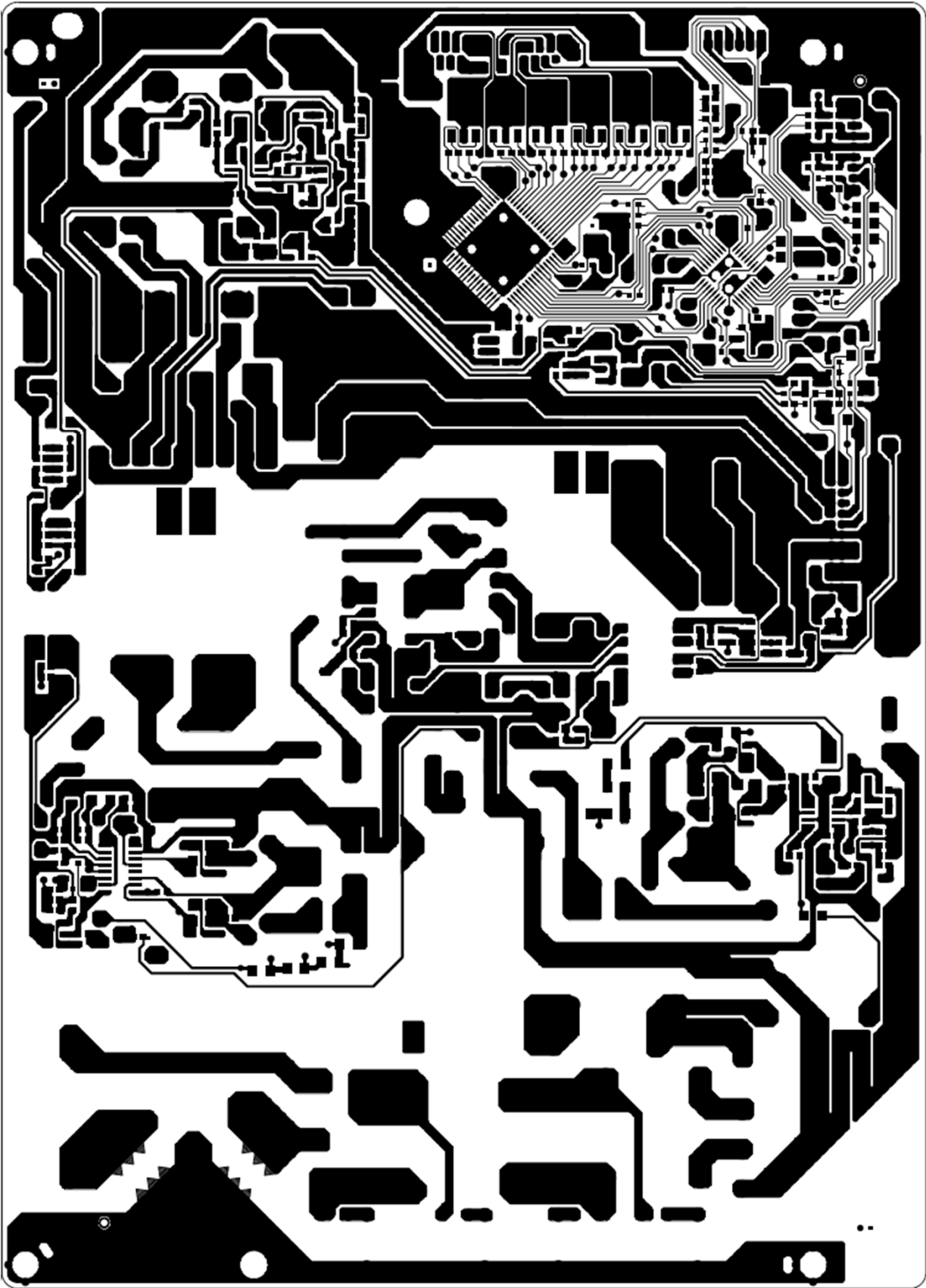
- D : 자삽
- M : SMD
- H : 수삽 최종
- I : ICT
- F : 1차 성능
- A : AGING
- P : HI-POT
- T : 최종 검사 (ATE)
- S : SET 검사
- Q : QC 검사
- R : 불량 수리
- RT : 양산 보증 시험

PCB Layout

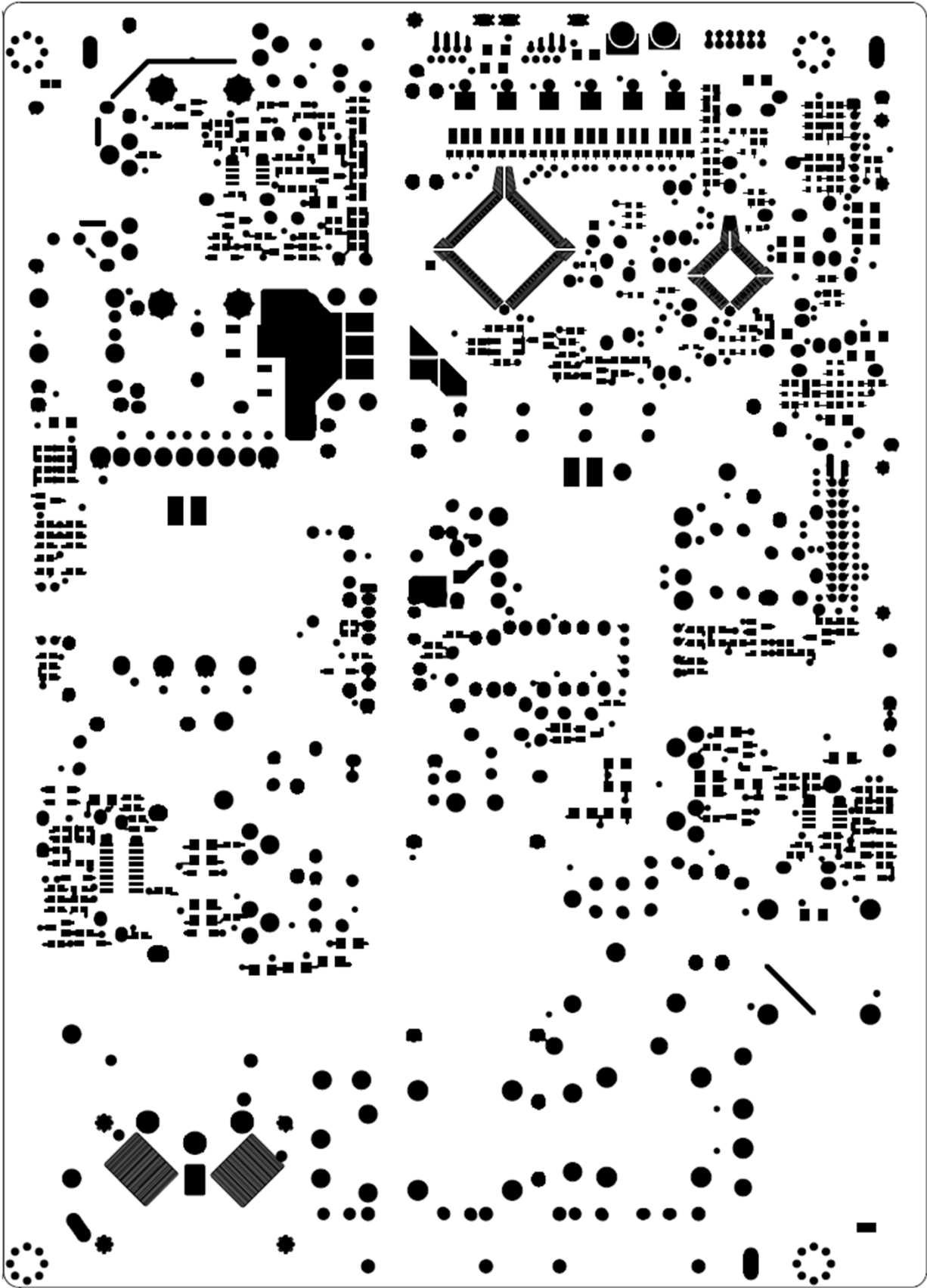
Top Silk



Bottom Pattern

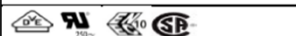
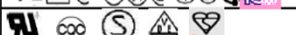
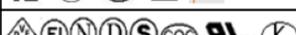
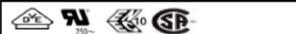
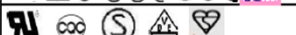
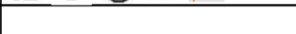


Bottom Solder mask



Safety Parts

Object/part No.	Manufacturer / Trademark	Type / Model	Value / Rating	Parts Marking (實物)	standard	mark(s) of conformity1)
AC input connector, (SK100)	Yeon Ho	90011WR-H03D	250V / 10A		IEC 60065 UL 1977	
Fuse, (F100)	Littelfuse Inc.	215 Series	T5A H / 250V	LF.T5AH250VP	IEC 60127-1	
	WALTER FUSE	TSC		TSC5A250V(P)	IEC 60127	
	Dainfuse	50CT		T5AH250V	IEC 60127	
	BUSSMANN	S505		T5AH250V	IEC 60127	
	CONQUIRE	UDA / UDA-A		UDA T5A H 250V	IEC 60127-3-5	
Fuse, (F101)	Littelfuse Inc.	876 Series	F2.0A L / 250V	LF2A F250V	IEC 60127-1	
	Dainfuse	30CF		F2A 250V	IEC 60127	
Fuse, (F501)	Littelfuse Inc.	876 Series	F1.6A L / 250V	LF1.6A F250V	IEC 60127-1	
	Dainfuse	30CF		F1.6A 250V	IEC 60127	
Line Filter, (LF101,LF102)	TNC	CSG10250S	Rated 130℃	G10250S	IEC 60065	Test in appliance
	Dongil Tech	LTG010250		G10250	IEC 60065	Test in appliance
	DONGYANG TELECOM	LLF-120		LLF-120		
	JIANGSU CHANNELON ELECTRONIC GROUP					
	FEELUX					
	SOOJUNG					
	JIANGSU TAICHANG ELECTRONICS Co.,LTD.					
Varistor, (VA101)	Samwha	SVC621D-14	620V,Min.	SVC621-14	IEC61051-2	
	Amotech Co., Ltd.	INR 14D621		INR 14D621		
	Xiamen Wanming Electronics Co.,Ltd	WMR14D621K		WMR 14D621K		
Bridge Diode, (BD101)	Rectron	RS1505M	Min. 600V / 15A	RS1505M	E94233	Test in appliance
	TSC	TS15P05G		TS15P05G	E96005	
	Lite-on	GUJ1506		GUJ1506		
	SHINDENGEN	D15XB60		D15XB60	E142422	
	GULF	G15XB60		G15XB60		
	DACHANG	D15SB60		D15SB60		
X-cap. (CX101,CX102)	Pilkor	PCX2 337	275V Max 0.33uF (CX101= 0.33uF, CX102= 0.33uF)	PCX2 337	IEC 60384-14 UL1414	
		PCX2 335M		PCX2 335M	IEC 60384-14 UL1414	
	SUNGHO	CMPP		CMPP	IEC 60384-14 UL1414/UL1283	
	Okaya	LE		LE	IEC 60384-14 UL1414	
	EUROPTRONIC	MPX		MPX	E199061/ E311052 IEC 60384-14-2'nd edition	
	CHENG TUNG	CTX		CTX	IEC 60384-14 UL1414	
Thermistor. (TH101,TH102)	DSC	DSC 2.5D-15	2.5ohm at 25 ° C	DSC 2.5D-15	IEC 60065	
	Xiamen Wanming Electronics Co.,Ltd	WTR 15D2R5		WTR 15D2R5		
	JIANGSU XINGSHUN ELECTRONICS CO., LTD	2.5D2-15		2.5D2-15		
	NANJING SHIHENG ELECTRONICS CO., LTD	MF72 2.5D15		MF72 2.5D15		
	SMART ELECTRONICS INC	ICL-5W	2.5ohm at 25 ° C	ICL-052R50MSMT		
Elec.Cap., (CG10)	SAMYOUNG	KMF	450V / Max 82uF / 105℃	KMF450V82uF	IEC 60950-1	Test in appliance
	SUSCON	SK		SK450V82uF		
	SAMWHA	LT		LT450V82uF		
	RUBYCON	BXC		BXC450V82uF		

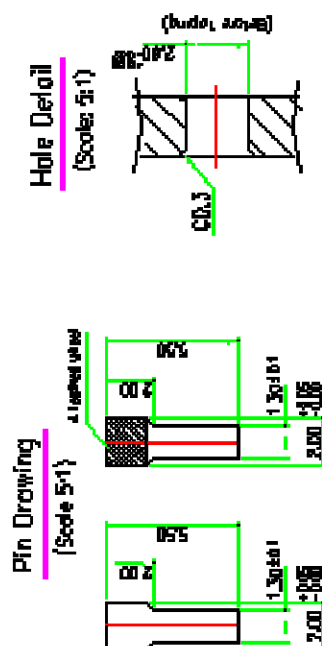
Switching TR, (Q601,Q602)	TOSHIBA	TK13AG0D	Min. 600V / Min 10A	K13AG0D	IEC 60950-1	Test in appliance
	STM	STF13NM6ON		13NM6ON		
	INFINEON	1PAG0R280E6		6R280E6		
	SILIKRON	SSF11NS60F		SSF11NS60F		
Switching TR, (Q101,Q102)	KEC	KF12N60F	Min. 600V / Min 7A	KF12N60	IEC 60950-1	Test in appliance
	TOSHIBA	TK10AG0D		K10AG0D		
	STM	STF10NM6ON		10NM6ON		
	MAGNACHIP	MDF11NG0		MDF11NG0		
	INFINEON	SD10NG0		SD10NG0		
Flyback IC, (1C501)	SANKEN	STR-A6059H	Min. 650 V / Min 1.8A	A6059H	IEC 60950-1	Test in appliance
Y Cap., (CY103,CY104, CY105,CY106)	Kunshan Wansheng	CT7		CT7 471K		
	Apex intec	NK		NK471K		
	DONG IL	DA		DA471K		
	YINANDON	CT81		CT81 471K		
	SAMWHA	SD		SD471K		
	JYA-NAY	JN		JN471K		
	GUANGDONG SOUTH HONGMING	F		F471K		
	TDK	CD		CD471K		
						
Bridging Cap., (CY107)	Kunshan Wansheng	CT7		CT7 471K		
	Apex intec	NK		NK471K		
	DONG IL	DA		DA471K		
	YINANDON	CT81		CT81 471K		
	SAMWHA	SD		SD471K		
	JYA-NAY	JN		JN471K		
	GUANGDONG SOUTH HONGMING	F		F471K		
	TDK	CD		CD471K		
						
PFC Coil,(LG01)	SOOJUNG	12S-LP01	Rated 130℃	12S-LP01	IEC 60950-1	Test in appliance
	BUJEON					
	DONG YANG TELECOM CO., LTD					
	LG Innotek					
	JIANGSU CHANNELON ELECTRONIC GROUP					
	TDK					
	FEELUX					
	JIANGSU TAICHANG ELECTRONICS Co.,LTD.					
	LIENCHANG					
Switching Transformer, (T101)	SOOJUNG	12S-LM05	Class B	12S-LM05	IEC 60950-1	Test in appliance
	BUJEON					
	DONG YANG TELECOM CO., LTD					
	LG Innotek					
	JIANGSU TAICHANG ELECTRONICS Co.,LTD.					
	JIANGSU CHANNELON ELECTRONIC GROUP.					
	TDK					
	FEELUX					
	LIENCHANG					
Switching Transformer, (T501)	SOOJUNG	12S-LS01	Class B	12S-LS01	IEC 60065	Test in appliance
	BUJEON					
	DONG YANG TELECOM CO., LTD					
	JIANGSU CHANNELON ELECTRONIC GROUP.					
	TDK					
	FEELUX					
	JIANGSU TAICHANG ELECTRONICS Co.,LTD.					
	Clover hi-tech Co., Ltd.					
	LIENCHANG					

Opto-coupler, (IC102,IC502,IC503)	Everlight	EL817	>0,4mm / Rated 6000Vac	EL817	IEC 60065 UL 1577	
	Lite-on	LTV817...		817BN		
Discharge Resistor, (R101)	Smart	PRC	1/2W, 1.2Mohm, 5%		IEC 60065	
	UNIROYAL ELECTRONICS INDUSTRY CO., LTD	MGR0#2J****A10				
	Pilkor	SR37,MSR37				
Capacitor (C601)	Pilkor	PCMP 372 (box) PCMP 472 (Film)	0.82uF / 500V	820n J 500V 372 MKP 824 J 500 P472 MPP	IEC60384-1	UL
	LUMEN	MP	0.82uF / 500V	M 824J MP 500V		
	EUROPTRONIC	MPHB	0.82uF / 500V	MPHB 824 J 500		
	Sung-Ho	MPP BMPP	0.82uF / 500V	824J 500V S MPP 824J 500V BMPP SH		
	CHENG TUNG	CTH	0.82uF / 500V	CTH 824 J 500V		
Capacitor (C114)	Pilkor	PCMP 384	0.018uF / 800V	18n J 800V 384 MMKP	IEC60384-1	UL
	LUMEN	NP	0.018uF / 800V	M 183J NP 800V		
	EUROPTRONIC	MPLB	0.018uF / 1000V	MPLB 183 J 1000		
	Sung-Ho	NPPS	0.018uF / 800V	183J S 800V NPPS		
	CHENG TUNG	PPN	0.018uF / 800V	PPN 183 J 800V		
PCB	DONGMYUNG CIR.	DM5-V-0	94V-0			
	SHANGHAI WANZHENG	SWZ-2	94V-0			
	SHENG KIUANG(WEI JUN)	03V0-C 03V0	94V-0			
	SHANGHAI AREX	02V0	94V-0			
	NEW TRIUNION	TU-3	94V-0			
	CHIN POON	E5	94V-0			
	TIANJIN DAEDUCK	DC-1 DC-2	94V-0			
	HUIHO	4B-5	94V-0			
	HISLAK KAO	07V0	94V-0			
	SAMHAN	SH7	94V-0			
	HT CIRCUIT(QINGDAO)	1994V0	94V-0			
	WONKYUNG	WK-1	94V-0			
	TIAN FENG	TU-1	94V-0			
	Duck sung	DS8-V-0	94V-0			
	TIS KOREA	TIS-3	94V-0			
	kyosha	2294V-0	94V-0			
	kyosha	S4594V-0	94V-0			
	Wellbest	MTV0-01	94V-0			
	Cosmotech	GS2-V-0-1 CJ2-V-0-1 CJ2-V-0-2	94V-0			
	CHANGZHOU HATHONG	CCE-V0	94V-0			

1) an asterisk indicates a mark which assures the agreed level of surveillance
Remarks: *) Large volume capacitors exceeding volume 1750mm³

Mechanical Drawing

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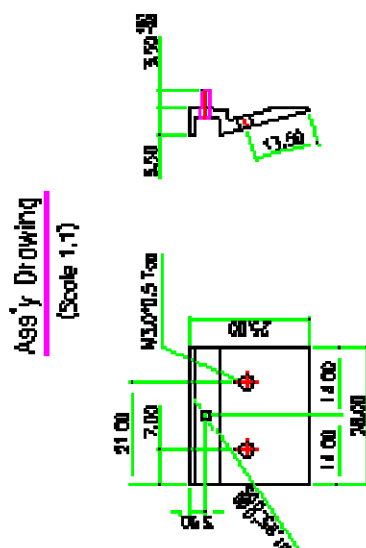


W3F

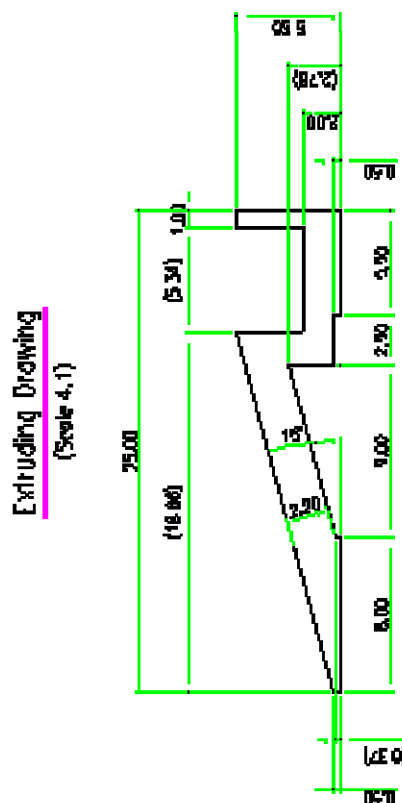
1. Unspecified tolerance is ± 0.2
2. Flatness and warpage should be less than 0.15
3. The electric connection must be secured between head sink and pin, (Electric resistance between pins in end of H/S: under 0.5 Ohm)
4. Cutting planes shouldn't be remained any sharp burrs could injure worker.
5. Any metallic particles, contaminations, scratches, dents and marks in surface of it couldn't be allowed
6. Pin shouldn't be taken out by specific pulling force is less than 3kgf. (Refer to below details)



7. Lugs should not be put out over Heat sink Body boundary
8. ρ_{max} : Critical to quality point
9. ρ_{min} : Critical point to control the dimension
10. All parts don't have to contain prohibited substances including RoHS hazardous substances (Pb, Cd, Hg, Cr+6, PBB, PBDE) and for more details refer to LGI's Eco-SM standard. LGI301-K-029



Agg'y Drawing
(Scale 1.1)



Extruding Drawing
(Scale 4:1)

Part No.	Name	Raw Material	Specification	Plating/Finish
—	Mn	90% ± 1.5	55(1) x 2 g(1)	Tin Plating (Cu Under Sn - 5um)
—	Lead Sink	A86013, Purge more than 99%	26(1) x 25(W x L x H)	Wedge Anodizing (Pc = 5um)
①	Spec Release	JIS	400	Heat Sink-2 (ANALYZER-A-B) MEASURE IN (2/2)

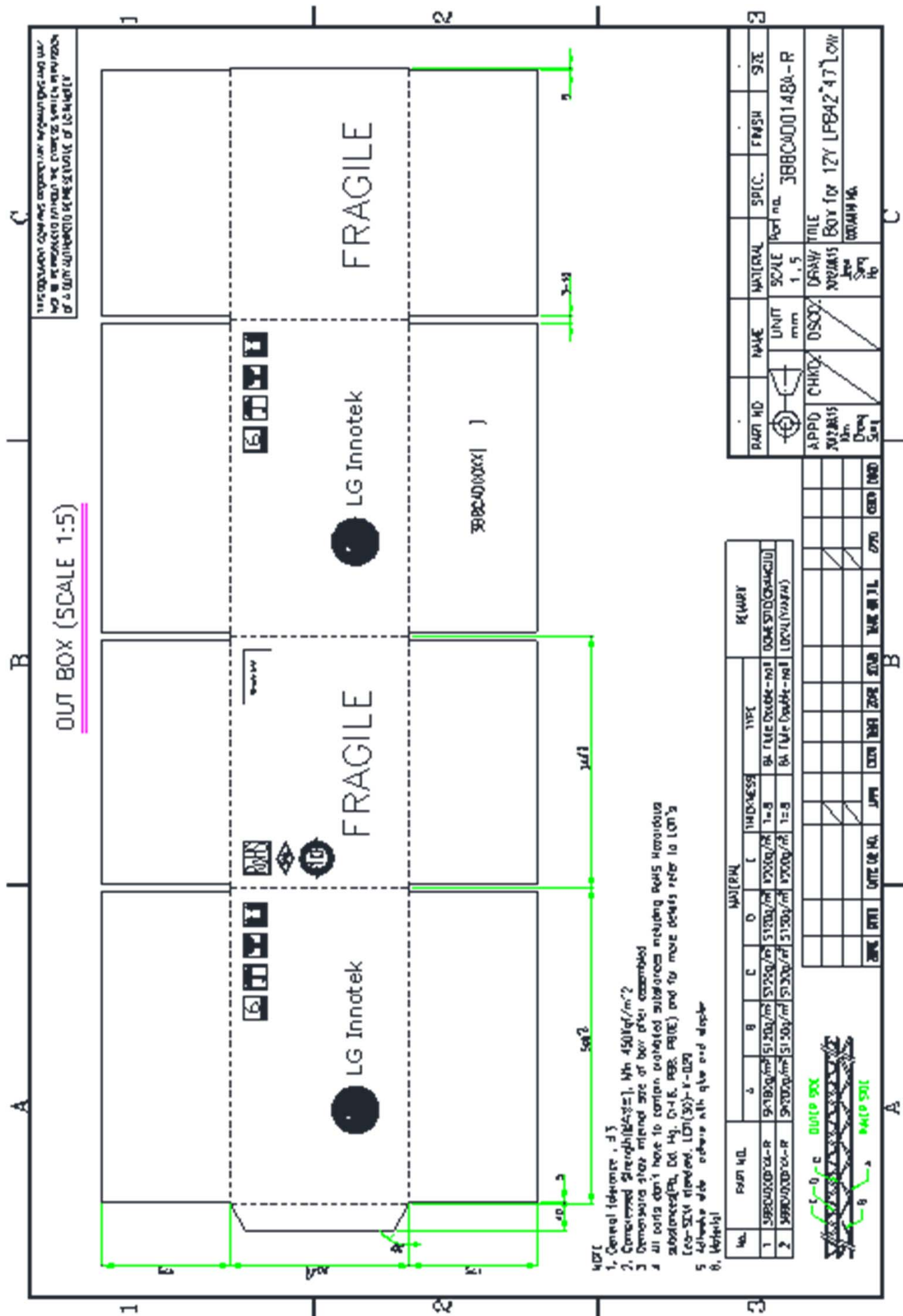


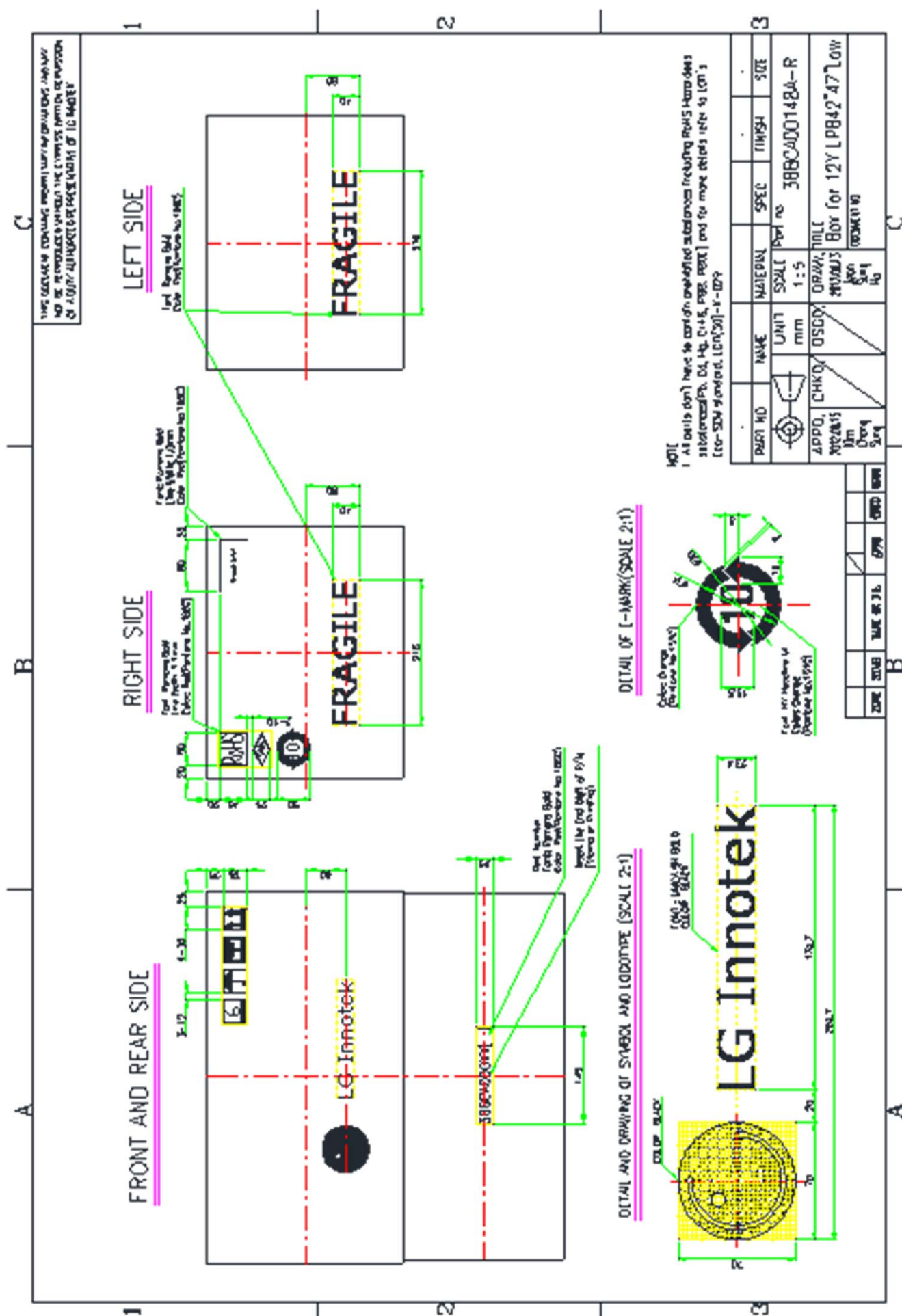
1. Unspecified tolerance is ± 0.15
2. Flatness and warpage should be less than 0.15
3. Cutting planes shouldn't be remained any sharp burrs could injure worker.
4. Any metallic particles, contaminations, scratches, dents and marks in surface of it couldn't be allowed
5. Surface treatment: Cu 1~6um, Sn 2~8um
6. "*" : CTQ(critical to quality point)
7. "**" : Critical point to control the dimension
8. All parts don't have to contain prohibited substances including RoHS hazardous substances(Pb,Cd,Hg,Cr+6,PBB,PBDE) and for more details refer to LGIT's Eco-SCM standard, LGIT(30)-K-029.

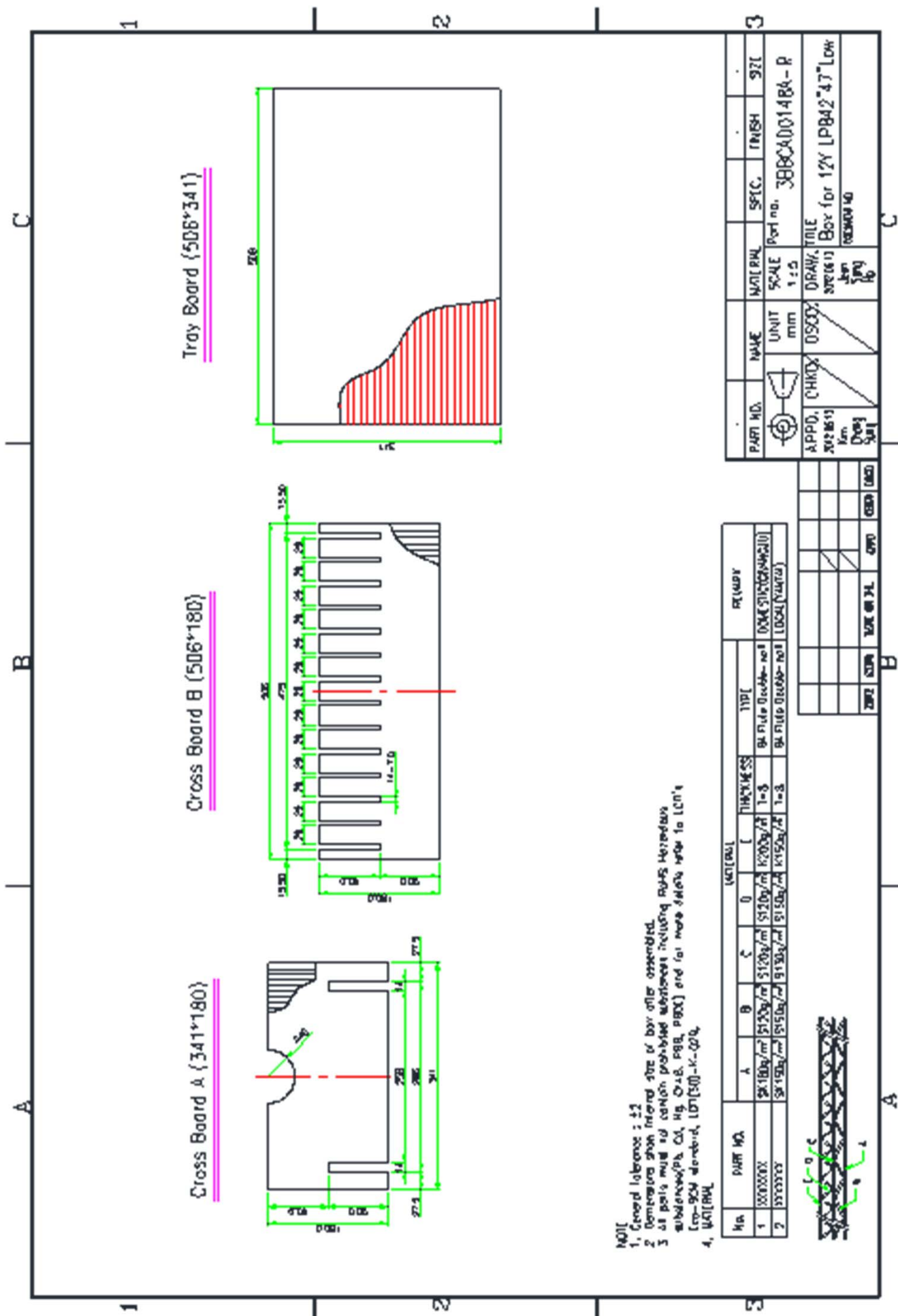
_____			Bracket		SPCC, 0.8t		27.8(L)x6.0(W)x7.2(H)			Tin Plating (Cu:1~6um,Sn:2~8um)	
PART NO.			NAME		MATERIAL		SPEC.			FINISH	
									UNIT mm	SCALE 1:2	LPB 42/47 Low CI
											
											
											
											
ZONE	SYMB	DATE OR NO.	APPD	CHKD	DSGD	APPD. 2012.02.03 Kim Chang Sung	CHKD.	DSGD.	DRAW. 2012.02.03 Jeon Sung Ho	TITLE Bracket for T0-220 (3HEAZA0XXXA-R)	
											DOCUMENT NO.

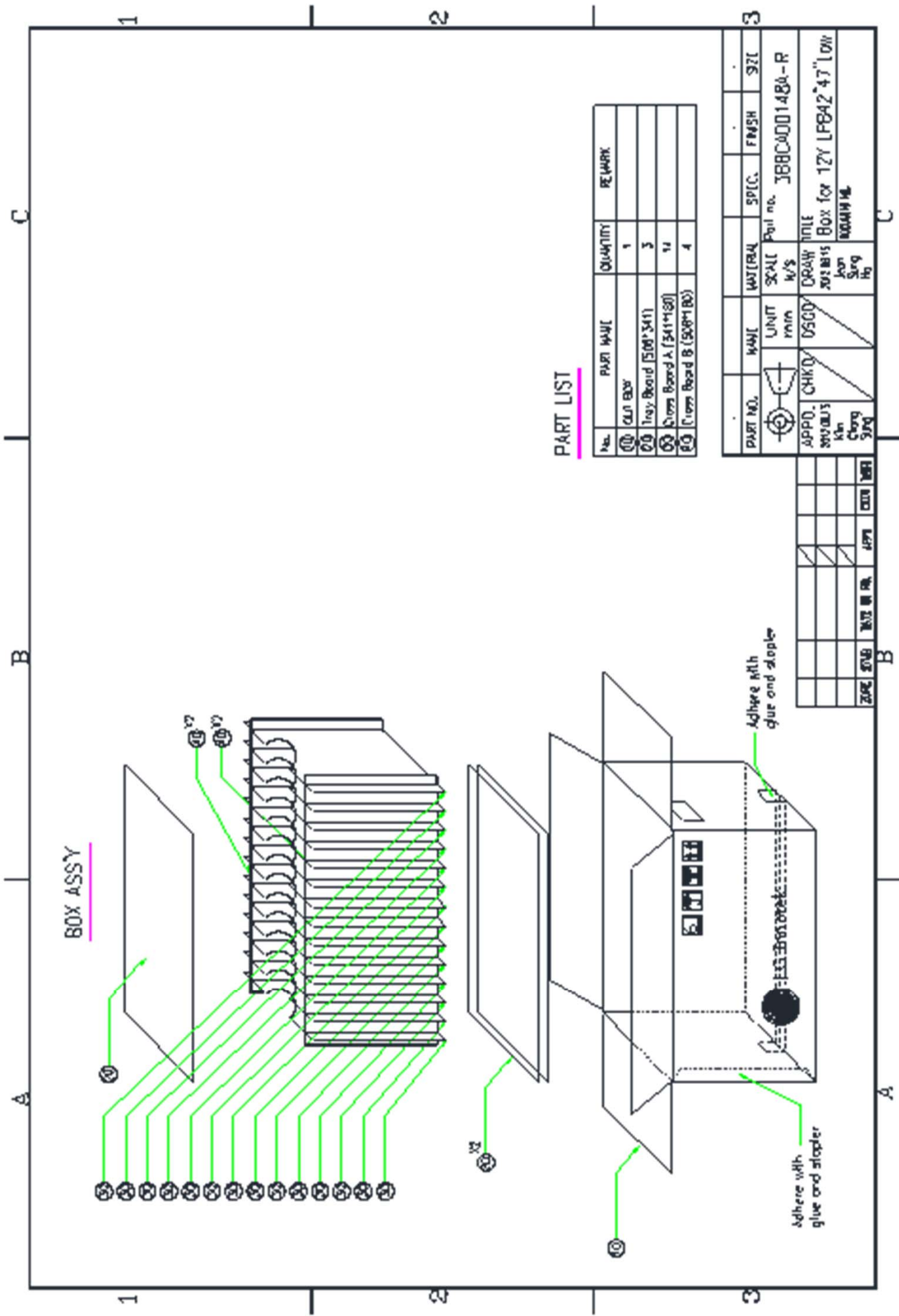


Packing Drawing







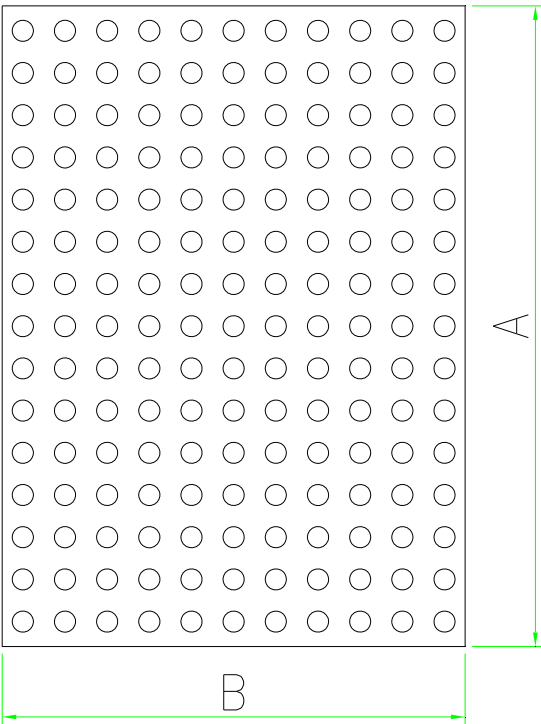


PART LIST

No.	PART NAME	QUANTITY	REMARK
10	BOX ASSY	1	
12	Tray Board (500*541)	3	
13	Tray Board A (541*500)	14	
14	Tray Board B (500*500)	4	

PART NO.	UNIT	QTY	SPC.	FINISH	SIZE
10	mm	1	1000	1000	1000
12	mm	3	1000	1000	1000
13	mm	14	1000	1000	1000
14	mm	4	1000	1000	1000

APPRO. SIGNATURE: [Signature]
DATE: [Date]
DRAWN: [Name]
CHECKED: [Name]
DESIGNED: [Name]
TITLE: Box for 12V LPB42*47" Low



- NOTE
- 1. Material : LDPE
 - 2. General tolerance :
 - 3. COLOR : PINK
 - 4. Antistatic finishing $+5_{-5}^6$
 - 5. Surface Resistance : $10^6 \sim 10^{11}$ Ohm/SQ
 - 6. LGIT (30)-K-029.
- All parts must not contain prohibited substances including RoHS azardous substances (Pb, Cd, Hg,Cr+6, PBB, PBDE) and for more details refer to LGIT's Eco-SCM standard,

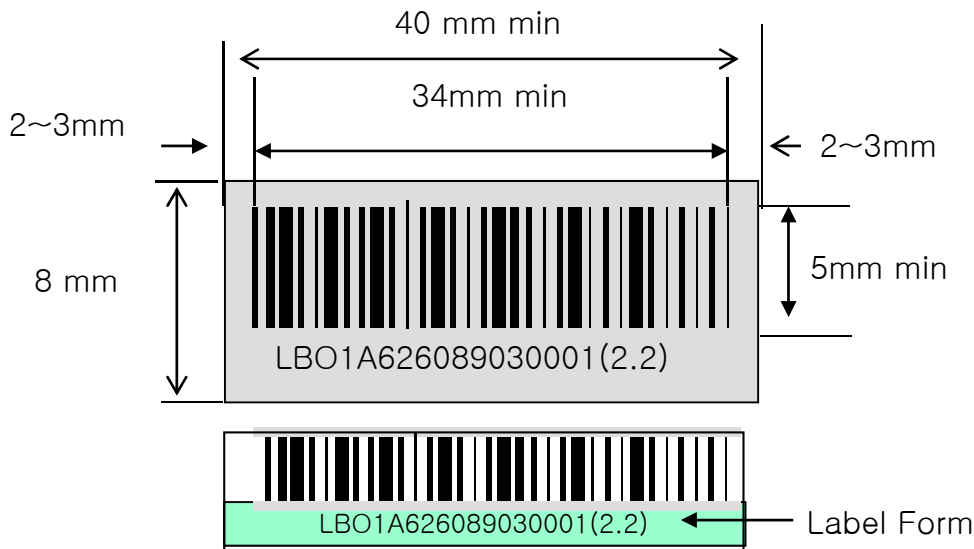
Part NO.	Thickness	"A"	"B"	Application Model	LGIT PCB Part Number
A	4 ±1.5	470	225	EPSU 32/37(162L*195W)	3EBDDB0001A-R
B	4 ±1.5	720	180	EPSU 42/47(245L*159W)	3EBDDB0002A-R
C	4 ±1.5	800	180	EPSU 55(270L*159W)	3EBDHA0001A-R
D	4 ±1.5	750	270	LPB 42/47(245L*243W)	3EBDDB0003A-R
E	4 ±1.5	760	200	LPB 42/47 Low(245L*174W)	3EBDGB0002A-R
F	4 ±1.5	750	270	LPB 55(270L*242W)	3EBDDB0003A-R
G	4 ±1.5	800	200	LPB 55 Low(270L*176W)	3EBDHB0002A-R

PART NO.		NAME		MATERIAL		SPEC.		FINISH	SIZE
							UNIT mm	SCALE NS	
						APPD.	CHKD.	DSGD.	DRAW.
						11.10.18			11.10.18
						Kim			Jeon
						Chang			Sung
						Sung			Ho
ZONE	SYMB	DATE OR NO.	APPD	CHKD	DSGD	TITLE Air Vinyl for 12Y			
						DOCUMENT NO. _____			

Bar-Code Label Drawing

1. BARCODE Specification

1.1 Power Board Barcode specification



※ Bar Code Size는 그림의 size가 최소size이며, 업체 기준 및 PCB공간에 따라 변경 할 수 있으나, 그림의 size보다 줄일 수 는 없음.

Code	Barcode Specification	Remark
Manufacturing code	L (L : LGIT)	
Manufacturing Year	B (B : 2011)	
Manufacturing Month	O (1,2,3,... 10:O, 11:N, 12:D)	
Manufacturing Date	1 (1~9,... A:10, B:11, C:12, ...X) * Don't USE : "I" ,"O" Character	
Manufacturing Line	A~D : Gwangju , E~N / 0~9 : Yantai , O~V : Indonesia , X~Z : Poland	
LG Part No.	62608903 (EAY62608903)	
Serial. No.	0001 (10Digit, 0001~9999)	
Rev. No	Approval Sheet Revision Number	
Barcode type : 93 code Barcode length : 17 digit Label size : 8 X 36 mm (minimize)		

※ BARCODE PRINTING : DO NOT ERASE, WHEN RUB BY HAND.
※ Label P/N : 3320KE0008B
Ribbon Black R300 P/N : 5250KR0011A

Labeling Point

Workmanship Point

Manufacturing Process

Manufacturing Process

제 / 개 공		개결사유		개결No.		제 / 개 공		관		관		관	
11.08.24		최초제결		0									

4M QC 공정도													
관리 No. : P/DF-L101B / P/LDK-L102B/P/DF-L103B/P/LDK-L104B/P/DF-L105C		종목 : 1. GIT		작성일자 : 11.08.24									
작성일자		작성일자											
4M													
공정번호		공정명		작업내용		MAN (시령)		Machine (장비)		Material (재료)		Method (방법)	
1		Incoming mat[ial]		해당 모델의 부품 부본과 수량을 확인하고 Box 하에 후 Tray에 적지		[자재 준비]		적립대, 이동대차, 라벨트레이너, 스케너		부품		수령 포장상태, 부본, Lot 상태, 일자	
2		[Eyelet]		PCB에 Eyelet, GT Pin을 삽입				Eyelet M/C		Eyelet		Program명, 모델명 확인, 삽입 좌표 조정 에어입력: 5.0Mg/rel ~ 이상	
3		[Jump Wire]		PCB에 Jump Wire를 삽입 후 플린칭				Jump Wire M/C 버니어 캘리퍼스 각도 측정 지그		Jump Wire		Cinching 길이:1.5±0.3mm Cinching 각도:15~35° 중도 삽입, 미삽 없을 것	
4		[Sequence]		Axial 지체를 순서와 규격에 맞게 Tare로 연결				Sequence M/C 버니어캘리퍼스		Axial 부품		테이퍼 치수 : 15.4±.55mm 부품 직경 : 0.3mm 이하 부품 간격: 5mm	
5		[Axial]		PCB에 Axial 부품을 삽입 후 플린칭				Axial M/C 버니어캘리퍼스 각도 측정 지그 버니어 캘리퍼스		부품 Sequence		Cinching 길이:1.2~1.5mm Cinching 각도:15~35° 불인, 미삽 발생하지 않을 것	
6		[이형 자산]		PCB에 이형 부품을 삽입 후 플린칭				M10 M/C 버니어 캘리퍼스		이형 부품		Cinching 길이:1.2~1.5mm Cinching 각도:15~35° 불인, 미삽 발생하지 않을 것	
7		[Radial]		PCB에 Radial 부품을 삽입 후 플린칭				Radial M/C 버니어 캘리퍼스 버니어 캘리퍼스		Radial 부품		Cinching 길이:1.2~1.5mm Cinching 각도:35° PCB와 극성 일치 불인, 미삽 발생하지 않을 것	

자 각 공 정 도									
* Process Symbols : V(Incoming), O (Working Flow Chart), ◇ (Inspection), □ (Packing), ▷(Delivery)									

Manufacturing Process

제 / 개 경		개경사유		개경No.	4M QC 공정도										관	경	일	지	
11.08.24		최초제정		0											/	/	/	/	
관리 No. : 오명명 : PLDF-L101B / PLDK-L102B/PLDF-L103B/PLDK-L104B/PLDF-L103C					제품명 : PLDF-L101B / PLDK-L102B/PLDF-L103B/PLDK-L104B/PLDF-L103C					제조사 : LGIT					작성일자 : 11.08.24				
										종목 : LIGHT									
										작성일자									
공정번호		공정도		공정명		작업내용		MMT (시작)		Machine (장비)		Material (재료)		4M		Method (방법)			
1				[자재준비]		해당 모델의 부품 부분과 수량을 확인하고 Box 하체 후 Tray에 적기				인고도경 제습합 부품포면/이동다자 바코드 스캔		부품		수행 도장상태, 부품 Lot 상태, 일자 LGIT/FDA 확인 BOM/MSD Level		제조 경각 오일 리스트 제품명 인증고 관리 리스트			
2				[Solder Cream]		Solder Cream 보관 및 사용				냉각고 Thermometer		Aim (LPM-48W TM+HF(L) SP-A93.0-Cu0.5		온도 관리 한계 : 1~10℃ 상온방치 2시간이상 교반시간 60초 ~120초		냉각 온도 관리 Sheet 냉각관리할 사항 이력 관리			
3				[Chip Bond]		Chip bond 보관 및 사용				냉각고 Thermometer		Chip Bond		온도 관리 한계 : 1~10℃ 상온방치 2시간이상		열상검정표 수리일지			
4				[본드 인쇄]		Stencil Mask를 Print하고 그위에 Bond를 투입한 후 PCB를 Loader로부터 꺼내 30s Squeegee로 압착작업을 취하 치에 인쇄				Mask Bond 인쇄기 Squeegee		Chip Bond		마스크 번호 2012 호 사이즈 : 0.8mm 3216 호 사이즈 : 1.2mm 집적회로 모델명 : HT-1300L 조도 광선시 투입량 : 300g 2400다 양 세그 후 보충 : 100g ~ 250g		마스크 입고시 확인 투입 Check Sheet			
5				[Chip Mount]		집 본딩된 PCB 위에 Chip 장착				Chip Mounter		부품		BOM, 도면 확인 자재, 고장 Check Mounting 상태 확인 Pick-up 상태 확인		조출전사발지 MES FDA 고대/기종전원 Check Sheet 부품 Loss를 기록표 작성전검정 기록표			
6				[이형 Mount]		집 본딩된 PCB 위에 이형 부품 장착 PCB에 장착된 부품 삽입 상태 검사(ACI)				Multi Mounter ACI		부품		BOM, 도면 확인 자재, 고장 Check Pick-up 상태 확인 OK, NG Sample로 장비 걸음		조출전사발지 MES FDA 고대/기종전원 Check Sheet 부품 Loss를 기록표 작성전검정 기록표			
6				[Reflow]		PCB에 부착된 부품을 고정하기 위해 납착제를 결화				Reflow M/C Pump/Pull Gauge				생산 도면과 프로그램 일치 할 것. 프로그램 온도, 조각표와 프로그램명 확인한다. 프로그램 온도 : 140℃ ~ 160℃ / 120℃ ~ 100℃		견착지도서 온도 조각표 프로그램명 고대/기종전원 Check Sheet			
														Chip, 열화 온도 1608 : 1.04g 이상 2012 : 1.34g 이상 3216 : 1.54g 이상		결합 경각 측정 Sheet			
* Process Symbols : V(Incoming), O (Working Flow Chart), ◇ (Inspection), □ (Packing), D(Delivery)																			

Manufacturing Process

제 4 차 개						
일자	개장사유		개정No.		작성	승인
11.08.24	최초제정	0			/	/
공정명 : PLDF-L101B / PLDK-L102B/PLDF-L103B/PLDK-L104B/PLDF-L103C						작성일 : 11.08.24
공정번호			공정명		작업내용	
1		[자동준비]	[이전 준비] 해당 모델의 부품 부재량 확인(이고 Box 해제 후 Tray에 이동)		Machining (금형) 입고도강 제품판 부품도강 이동장치	Material (재료) 부품
2		[수집공정]	[자동삽입] 바코드 라벨 발행		PC Barcode 라벨 프린터 스캐너	Ribbon 라벨
3		[수집공정]	P/C에 부품 삽입		수상 컨테이너 납땜 지그 부품적치대(부품다차) P/S캐러	부품 성리핀
4		[Flux공정]	P/C 하단에 Flux 분사		Flux M/C 미용계	Flux
5		[WaveSoldering 공정]	Soldering		Wave Soldering M/C Solder 자동 공급기 Wave Checker	Solder
5		[납땜 검사 및 수검 공정]	Soldering 된 제품을 납땜상태 검사 및 수검		인두기 인두 온도 측정기 수검 컨테이어	제품
6		[ICT 공정]	P/C에 장착된 부품 상태 검사		ICT M/C (AT-01) Fixture PC	제품
7		[통과검사]	제품 통과 검사		Etkan 저속기 Inline 선별기, PC Barcode Scanner	제품
8		[내압검사]	제품 내압 검사		Fixture 내압기 Inline 선별기	제품
9		[설리온도포]	설리온도포		Dispenser	설리본
10		[Aging공정]	제품 Aging 검사		Aging M/C Soldered 후시보하 Cable	제품
11		[최종외관검사]	제품 외관검사			제품
12		[특수검사]	제품 특성 검사		Etkan 저속기 Inline 선별기, PC Barcode Scanner	제품
13		[포장]	제품 포장		Barcode Scanner PC	제품 Box 에어버블
* Process Symbols : V(Vacuum) O (Working Flow Chart) ◇ (Inspection) □ (Packaging) ▷(Delivery)						

※ APPENDIX LIST

No.	Contents
1	Power Check List
2	WARRENTY LETTER (RoHS)

POWER CHECK LIST

WARRANTY LETTER

비사용 증명서

구분	☒ 승인용 ☐ 양산용	제출일자	2012 . 02 . 09	
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협력회사				
회사명	LG 이노텍	결재	담당자	부서장
연락처	Tel 062-950-0232	성명	김 인 재	김 형 성
e-mail	ijkim@ginnotek.com	서명		

부품정보			
LG전자 P/No.	EAY62608903	부품제조일자	
Maker P/No.	PLDF-L103C	생산 공장	LGIT Yantai, Gwangju
부품명(품명)	LGP4247L-12LPB-3PM		

당사가 납품하는 납입품 및 당사 제조 공정상 사용되는 물질이 아래 Check 항목에 대해 만족함을 증명합니다.

————— 아 래 —————

☒ ROHS 규제 6대 물질(Pb, Cd, Cr⁶⁺, Hg, PBBs, PBDEs)이 LG전자 Display 사업부 기준을 만족함

※ 아래 항목은 PCB(Printed Circuit Board)에 장착되는 부품일 경우 기록 요망

Soldering Type : ☒ Flow ☐ Reflow

최대 내열성 온도 : 260 °C 최대 내열성 시간 : 10 sec.

☒ Pb-Free Soldering (Solder Cream, Bar, Wire 모두 포함) 적용이 가능함

- Note.
- 1. 본 자료 상의 모든 기재 내용은 사실에 근거하여 작성하여야 하며, LG전자가 근거 자료를 요구 시, 관련 Data를 제출하여야 한다.
 - 2. 본 자료가 승인용으로 사용될 경우 Sample과 함께 제출하고, 양산용으로 사용될 경우 초품 입고시 제출하여야 한다.
 - 3. LG 전자 Display 사업부에 공급되는 PCB 장착 부품의 내열 기준은 다음과 같음.
Flow 부품 : 260℃/10 sec , Reflow 부품 : 250℃/10 sec

